ST52T430/E430

## 8-BIT INTELLIGENT CONTROLLER UNIT (ICU) Three Timer/PWMs, ADC, SCI

PRELIMINARY DATASHEET

## Memories

- Up to 8 Kbytes EPROM/OTP
- 256 bytes of RAM
- Readout Protection


## Core

- Register File Based Architecture
- 55 instructions
- Hardware multiplication and division
- Decision Processor for the implementation of Fuzzy Logic algorithms


## Clock and Power Supply

- Up to 20 MHz clock frequency.
- Power Saving features


## Interrupts

- 6 interrupt vectors
- Top Level External Interrupt (INT)


## Peripherals

- 3 Programmable 8-bit Timer/PWMs with internal 16-bit Prescaler featuring:
- PWM output
- Input capture
- Output Compare
- Pulse Generator mode
- Watchdog timer
- On-chip 8-bit Sample and Hold A/D Converter with 8-channel analog multiplexer
- Serial Communication Interface with asynchronous protocol (UART)



## I/O Ports

- 23 I/O PINs configurable in Input and Output mode
- High current sink/source in all pins.


## Development tools

- High level Software tools
- Emulator
- Low cost Programmer
- Gang Programmer

ST52x430 Devices Summary

| Device | NVM | RAM | Timer <br> PWM | ADC | SCI | Watchdog | Operating <br> Supply | I/O | Package |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ST52T430K1 | 2 K OTP | 256 | $3 \times 8-$-bit | $8-\mathrm{Ch}$ | Yes | Yes | $3.0-5.5 \mathrm{~V}$ | 23 | Sdip32 Sso34 Tafp32 |
| ST52T430K2 | 4 K OTP | 256 | $3 \times 8-$-bit | $8-\mathrm{Ch}$ | Yes | Yes | $3.0-5.5 \mathrm{~V}$ | 23 | Sdip32 Sso34 Tafp32 |
| ST52T430K3 | 8 K OTP | 256 | $3 \times 8-$-bit | $8-\mathrm{Ch}$ | Yes | Yes | $3.0-5.5 \mathrm{~V}$ | 23 | Sdip32 Sso34 Tafp32 |
| ST52E430K3 | 8 K EPROM | 256 | $3 \times 8-$-bit | $8-\mathrm{Ch}$ | Yes | Yes | $3.0-5.5 \mathrm{~V}$ | 23 | Csdip32w |

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## 1 GENERAL DESCRIPTION

### 1.1 Introduction

ST52×430 is an 8-bit Intelligent Control Units (ICU) of the ST Five Family, which can perform both boolean and fuzzy algorithms in an efficient manner, in order to reach the best performances that the two methodologies allow.
ST52x430 is produced by STMicroelectronics using the reliable high performance CMOS process, including integrated-on-chip peripherals that allow maximization of system reliability, decreasing system costs and minimizing the number of external components.
The flexible I/O configuration of ST5 $2 \times 400 / 440$ allows for an interface with a wide range of external devices, like D/A converters or power control devices.
ST52×430 pins are configurable, allowing the user to set the input or output signals on each single pin.
A hardware multiplier ( 8 bit by 8 bit with 16 bit result) and a divider ( 16 bit over 8 bit with 8 bit result and 8 bit remainder) are available to implement complex functions by using a single instruction. The program memory utilization and computational speed is optimized.
Fuzzy Logic dedicated structures in ST52x430 ICU's can be exploited to model complex systems with high accuracy in a useful and easy way.
Fuzzy Expert Systems for overall system management and fuzzy Real time Controls can be designed to increase performances at highly competitive costs.
The linguistic approach characterizing Fuzzy Logic is based on a set of IF-THEN rules, which describe the control behavior, as well as on Membership Functions, which are associated to input and output variables.
Up to 334 Membership Functions, with triangular and trapezoidal shapes, or singleton values are available to describe fuzzy variables.
The Timer/PWM peripheral allows the management of power devices and timing signals, implementing different operating modes and high frequency PWM (Pulse With Modulation) controls. Input Capture and Output Compare functions are available on the TIMER.
The programmable Timer has a 16 bit Internal Prescaler and an 8 bit Counter. It can use internal or external Start/Stop signals and clock.
An internal programmable Watchdog is available to avoid loop errors and to reset the ICU.
ST52x430 includes an 8-bit Analog to Digital Converter with an 8 -analog channel Multiplexer. Single/Multiple channels and Single/Sequence conversion modes are supported.

A Serial Communication peripheral (SCI), which uses the UART protocol allows data transfer from the ST52x430 to other external devices.
In order to optimize energy consumption, two different power saving modes are available: Wait mode and Halt mode.
Program Memory (EPROM/OTP) addressing capability addresses up to 8 Kbytes of memory locations to store both program instructions and permanent data.
EPROM can be locked by the user to prevent external undesired operations.
Operations may be performed on data stored in RAM, allowing the direct combination of new input and feedback data. All bytes of RAM are used like Register File.
OTP (One Time Programmable) version devices are fully compatible with the EPROM windowed version, which may be used for prototyping and pre-production phases of development.
A powerful development environment consisting of a board and software tools allows an easy configuration and use of ST52×430.
The VISUAL FIVE ${ }^{\text {TM }}$ software tool allows development of projects through a user-friendly graphical interface and optimization of generated code.

### 1.2 Functional Description

ST52x430 ICU can work in two modes:

- Memory Programming Mode
- Working Mode
according to RESET and Vpp signals levels (see pins description).
Note: When RESET=0 it is advisable not to use the sequence "101010" to port PA $7: 2$ ).


### 1.2.1 Memory Programming Mode.

The ST52×430 memory is loaded in the Memory Programming Phase. All fuzzy and standard instructions are written inside the memory.
This phase starts by setting the control signals as illustrated below:

| RESET | TEST | $\mathrm{V}_{\mathrm{PP}}$ |
| :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{ss}}$ | $\mathrm{V}_{\mathrm{ss}}$ | $12 \mathrm{~V} / \mathrm{V}_{\mathrm{DD}}$ |

When this phase starts, the ST52×430 core is set to RESET status; then 12 V are applied to the Vpp
pin in order to start EPROM programming. A signal applied to PB1 is used to increment the memory address; the data is supplied to PORT A (see EPROM programming for further details).

### 1.2.2 Working mode.

Below are the control signals of this mode:

| RESET | TEST | $\mathrm{V}_{\mathrm{PP}}$ |
| :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{SS}}$ | $\mathrm{V}_{\mathrm{SS}}$ |

The processor starts the working phase following the instructions, which have been previously loaded in the memory.
ST52x430's internal structure includes a computational block, CONTROL UNIT (CU) / DATA PROCESSING UNIT (DPU), which allows processing of boolean functions and fuzzy algorithms.

The CU/DPU can manage up to 334 different Membership Functions for the fuzzy rules antecedent part. The rule consequents are "crisp" values (real numbers). The maximum number of rules that can be defined is limited by the dimensions of the implemented standard algorithm.
EPROM is then shared between fuzzy and standard algorithms. The Membership Function data is stored inside the first 1024 memory locations. The Fuzzy rules are parts of the program instructions.
The Control Unit (CU) reads the information and the status deriving from the peripherals.
Arithmetic calculus can be performed on these values by using the internal CU and the 128/256 bytes of RAM, which supports all computations. The peripheral input can be fuzzy and/or arithmetic output, or the values contained in Data RAM and EPROM locations.

Figure 1.1 TQFP32 Pin Configuration


Figure 1.2 SSO34 Pin Configuration


Figure 1.3 PSDIP32 Pin Configuration


Table 1.1 ST52x430 SSO34 \& PSDIP32 Pin list

| $\begin{gathered} \text { SSO34 } \\ \text { Pins } \end{gathered}$ | $\begin{aligned} & \text { SDIP32 } \\ & \text { Pins } \end{aligned}$ | NAME | Programming Phase | Working Phase |
| :---: | :---: | :---: | :---: | :---: |
| 1 | 1 | RESET | General Reset | General Reset |
| 2 | 2 | OSCOUT |  | Oscillator Output |
| 3 | 3 | OSCIN |  | Oscillator Input |
| 4 | 4 | TEST | Must be tied to $\mathrm{V}_{\text {ss }}$ | Must be tied to $\mathrm{V}_{\text {ss }}$ |
| 5 | 5 | INT/PC0 | PHASE signal (PHASE) | External interrupt, Digital I/O |
| 6 | 6 | T00UT/PC1 |  | Timer/PWM 0 output, Digital I/O |
| 7 | 7 | T1OUT/PC2 |  | Timer/PWM 1 output, Digital I/O |
| 8 | 8 | T2OUT/PC3 |  | Timer/PWM 2 output, Digital I/O |
| 9 | 9 | TX/PC4 |  | SCI Output, Digital I/O |
| 10 | 10 | RX/PC5 |  | SCI Input, Digital I/O |
| 11 | 11 | PC6 |  | Digital I/O |
| 12 | 12 | PC7 |  | Digital I/O |
| 13 |  | nc |  |  |
| 14 | 13 | Ain0/PB0 | Address Reset (RST_ADD) | Analog Input, Digital I/O |
| 15 | 14 | Ain1/PB1 | Address Increment (INC_ADD) | Analog Input, Digital I/O |
| 16 | 15 | Ain2/PB2 | Configuration Reset (RST_CONF) | Analog Input, Digital I/O |
| 17 | 16 | Ain3/PB3 | Configuration Increment (INC_CONF) | Analog Input, Digital I/O |
| 18 | 17 | VDDA | Analog Power Supply | Analog Power Supply |
| 19 | 18 | GNDA | Analog Ground | Analog Ground |
| 20 | 19 | Ain4/PB4 |  | Analog Input, Digital I/O |
| 21 | 20 | Ain5/PB5 |  | Analog Input, Digital I/O |
| 22 |  | nc |  |  |
| 23 | 21 | Ain6/PB6 |  | Analog Input, Digital I/O |
| 24 | 22 | Ain7/PB7/PA7 | I/O EPROM Data | Analog Input, Digital I/O |
| 25 | 23 | PA6 | I/O EPROM Data | Digital I/O |
| 26 | 24 | T0CLK/PA5 | I/O EPROM Data | Timer/PWM 0 clock, Digital I/O |
| 27 | 25 | TOSTRT/PA4 | I/O EPROM Data | Timer/PWM 0 start/stop, Digital I/O |
| 28 | 26 | T2OUT/PA3 | I/O EPROM Data | Timer/PWM 2 compl. output, Digital I/O |
| 29 | 27 | T10UT/PA2 | I/O EPROM Data | Timer/PWM 1 compl. output, Digital I/O |
| 30 | 28 | T00UT/PA1 | I/O EPROM Data | Timer/PWM 0 compl. output, Digital I/O |
| 31 | 29 | TORES/PA0 | I/O EPROM Data | Timer/PWM 0 Reset, Digital I/O |
| 32 | 30 | VPP | EPROM Programming Power supply ( $12 \mathrm{~V} \pm 5 \%$ ) | EPROM Vdd or Vss |
| 33 | 31 | Vss | Digital Ground | Digital Ground |
| 34 | 32 | VDD | Digital Power Supply | Digital Power Supply |

Table 1.2 ST52×430 TQFP32 Pin list

| TQFP32 Pins | NAME | Programming Phase | Working Phase |
| :---: | :---: | :---: | :---: |
| 1 | INT/PC0 | PHASE signal (PHASE) | External interrupt, Digital I/O |
| 2 | T0OUT/PC1 |  | Timer/PWM 0 output, Digital I/O |
| 3 | T1OUT/PC2 |  | Timer/PWM 1 output, Digital I/O |
| 4 | T2OUT/PC3 |  | Timer/PWM 2 output, Digital I/O |
| 5 | TX/PC4 |  | SCI Output, Digital I/O |
| 6 | RX/PC5 |  | SCI Input, Digital I/O |
| 7 | PC6 |  | Digital I/O |
| 8 | PC7 |  | Digital I/O |
| 9 | Ain0/PB0 | Address Reset (RST_ADD) | Analog Input, Digital I/O |
| 10 | Ain1/PB1 | Address Increment (INC_ADD) | Analog Input, Digital I/O |
| 11 | Ain2/PB2 | Configuration Reset (RST_CONF) | Analog Input, Digital I/O |
| 12 | Ain3/PB3 | Configuration Increment (INC_CONF) | Analog Input, Digital I/O |
| 13 | Vdda | Analog Power Supply | Analog Power Supply |
| 14 | GNDA | Analog Ground | Analog Ground |
| 15 | Ain4/PB4 |  | Analog Input, Digital I/O |
| 16 | Ain5/PB5 |  | Analog Input, Digital I/O |
| 21 | Ain6/PB6 |  | Analog Input, Digital I/O |
| 22 | Ain7/PB7/PA7 | I/O EPROM Data | Analog Input, Digital I/O |
| 19 | PA6 | I/O EPROM Data | Digital I/O |
| 20 | T0CLK/PA5 | I/O EPROM Data | Timer/PWM 0 clock, Digital I/O |
| 21 | TOSTRT/PA4 | I/O EPROM Data | Timer/PWM 0 start/stop, Digital I/O |
| 22 | T2OUT/PA3 | I/O EPROM Data | Timer/PWM 2 compl. output, Digital I/O |
| 23 | T1OUT/PA2 | I/O EPROM Data | Timer/PWM 1 compl. output, Digital I/O |
| 24 | T00UT/PA1 | I/O EPROM Data | Timer/PWM 0 compl. output, Digital I/O |
| 25 | TORES/PA0 | I/O EPROM Data | Timer/PWM 0 Reset, Digital I/O |
| 26 | VPP | EPROM Programming Power supply $(12 \mathrm{~V} \pm 5 \%)$ | EPROM Vdd or Vss |
| 27 | Vss | Digital Ground | Digital Ground |
| 28 | VDd | Digital Power Supply | Digital Power Supply |
| 29 | RESET | General Reset | General Reset |
| 30 | OSCOUT |  | Oscillator Output |
| 31 | OSCIN |  | Oscillator Input |
| 32 | TEST | Must be tied to $\mathrm{V}_{\text {ss }}$ | Must be tied to $\mathrm{V}_{\text {ss }}$ |

### 1.3 Pin Description

$\mathbf{V}_{\mathbf{D D}}, \mathbf{V}_{\mathbf{S S}}, \mathbf{V}_{\mathrm{DDA}}$, GNDA, $\mathbf{V}_{\mathbf{P P}}$. In order to avoid noise disturbances, the power supply of the digital part is kept separate from the power supply of the analog part.
$V_{D D}$. Main Power Supply Voltage ( $5 \mathrm{~V} \pm 10 \%$ ).
$\mathrm{V}_{\mathrm{SS}}$. Digital circuit ground.
$\mathrm{V}_{\text {DDA }}$. Analog $\mathrm{V}_{\mathrm{DD}}$ of the Analog to Digital Converter.
GNDA. Analog $V_{S S}$ of the Analog to Digital Converter. Must be tied to $\mathbf{V}_{\text {Ss }}$.
$\mathbf{V}_{\text {pp }}$. Main Power Supply for internal EPROM ( $12.5 \mathrm{~V} \pm 5 \%$, in programming phase) and MODE selector. During the Programming phase (programming), $\mathrm{V}_{\text {PP }}$ must be set at 12 V . In the Working phase $\mathrm{V}_{\mathrm{PP}}$ must be equal to $\mathrm{V}_{\mathrm{SS}}$.
OSCin and OSCout. These pins are internally connected with the on-chip oscillator circuit. A quartz crystal or a ceramic resonator can be connected between these two pins in order to allow the correct operations of ST52×430 with various stability/cost trade-off. An external clock signal can be applied to OSCin, in this case OSCout must be floating.
RESET. This signal is used to restart ST5 $2 \times 430$ at the beginning of its program. It also allows one to select the program mode for EPROM.
Ain0-Ain8. These 8 lines are connected to the input of the analog multiplexer. They allow the
acquisition of 8 analog input. During the Programming phase, Ain0, Ain1, Ain2 and Ain3 are used to manage EPROM operation.
PA0-PA7, PB0-PB7, PC0-PC7. These lines are organized as I/O port. Each pin can be configured as input or output. PA7/PB7 are tied to the same output. During Programming phase PA port is used for EPROM read/write data.
TORES, TOCLK, TOSTRT. These pins are related with the internal Programmable Timer/PWM 0. This Timer can be reset externally by using TORES. In Working Mode, TORES resets the address counter of the Timer. TORES is active at low level.
The Timer 0 Clock can be the internal clock or can be supplied externally by using pin TOCLK.
An external Start/Stop signal can be used to control the Timer through TOSTRT pin.
TOOUT, T1OUT, T2OUT. The TIMER/PWM outputs are available on these pins.
TOOUT, T1OUT, T2OUT. The TIMER/PWM complementary outputs are available on these pins.
Tx. Serial data output of SCI transmitter block
Rx. Serial data input of the SCI receiver block.
TEST. During the Programming and Working phase it must be set to Vss.

Figure 1.4 ST52X430 Block Diagram


## 2 INTERNAL ARCHITECTURE

ST52×430 is made up of the following blocks and peripherals:

- Control Unit (CU) and Data Processing Unit (DPU)
- ALU / Fuzzy Core

■ EPROM

- 256 Byte RAM
- Clock Oscillator
- Analog Multiplexer and A/D Converter
- 3 PWM / Timers
- SCI
- Digital I/O port


### 2.1 ST52x430 Operating Modes

ST52×430 works in two modes, Programming and Working Modes, depending on the control signals level RESET, TEST and VPP
The Operating modes are selected by setting the control signal level as specified in the Control Signals Setting table.

Table 2.1 Control Signals Setting

| Control <br> Signal | Pro- <br> gramming | Reset | Working |
| :---: | :---: | :---: | :---: |
| RESET | Vss | Vss | VDD |
| TEST | Vss | Vss | Vss |
| VPP | 12 V | Vss | Vss |

### 2.2 Control Unit and Data Processing Unit

The Control Unit (CU) formally includes five main blocks. Each block decodes a set of instructions, generating the appropriate control signals. The main parts of the CU are illustrated in Figure 2.1.
The five different parts of the CU manage Loading, Logic/Arithmetic, Jump, Control and the Fuzzy instruction set.
The block called "Collector" manages the signals deriving from the different parts of the CU, defining the signals for the Data Processing Unit (DPU) and the different peripherals of the microcontroller.
The block called "Arbiter" manages the different-
parts of the CU so that only one part of the system is activated during working mode.
The CU structure is very flexible. It was designed with the purpose of easily adapting the core of the microcontroller to market needs. New instruction sets or new peripherals can be easily included without changing the structure of the microcontroller, maintaining code compatibility.
The CU reads the instructions stored on EPROM (Fetch) and decodes them. According to the instruction types, the arbiter activates one of the main blocks of the CU. Afterwards, all the control signals for the DPU are generated.
A set of 46 different arithmetic, fuzzy and logic instructions is available. Each instruction requires 6 (fuzzy instructions) to 26 (DIVISION) clock pulses to be performed.
The DPU receives, stores and sends instructions deriving from EPROM, RAM or peripherals in order to execute them.

### 2.2.1 Program Counter.

The Program Counter (PC) is a 13-bit register that contains the address of the next memory location to be processed by the core. This memory location may be an opcode, operand, or an address of an operand.
The 13-bit length allows direct addressing of a maximum of 8,192 bytes in the program space.
After having read the current instruction address, the PC value is incremented. The result of this operation is shifted back into the PC.
The PC can be changed in the following ways:

- JP (Jump)PC = Jump Address
- InterruptPC = Interrupt Vector
- RETIPC = Pop (stack)
- RETPC = Pop (stack)
- CALLPC = Subroutines address
- ResetPC = Reset Vector
- Normal InstructionPC = PC + 1


### 2.2.2 Flags.

The ST52×430 core includes a different set of flags that correspond to 2 different modes: normal mode and interrupt mode. Each set of flags consists of a CARRY flag (C), ZERO flag (Z) and SIGN flag (S).
One set (CN, ZN, SN) is used during normal operation and one is used during interrupt mode ( $\mathrm{Cl}, \mathrm{ZI}, \mathrm{SI}$ ). Formally, the user has to manage only one set of flags: $C, Z$ and $S$.

Figure 2.1 Data Processing Unit (DPU)


Figure 2.2 CU/DPU Block Diagram


EPROM Address

The ST52x430 core uses flags that correspond to the actual mode. As soon as an interrupt is generated the ST52×430 core uses the interrupt flags instead of the normal flags.
Each interrupt level has its own set of flags, which is saved in the STACK together with the Program Counter. These flags are restored from the STACK automatically when a RETI instruction is executed. If the MCU was in normal mode before an interrupt, the normal flags are restored when the RETI instruction is executed.
Note: A CALL subroutine is a normal mode execution. For this reason, a RET instruction, consequent to a CALL instruction does not affect the normal mode set of flags.
Flags are not cleared during context switching and remain in the state they were at the end of the last interrupt routine switching.
The Carry flag is set when an overflow occurs during arithmetic operations, otherwise it is cleared.
The Sign flag is set when an underflow occurs during arithmetic operations, otherwise it is cleared.

### 2.3 Address Spaces

ST52×430 has four separate address spaces:
■ RAM: 256 Bytes

■ Input Registers: 20 8-bit registers

- Output Registers 108 -bit registers

■ Configuration Registers: 21 8-bit registers

- Program memory up to 8K Bytes

Program memory will be described in further details in the MEMORY section

### 2.3.1 RAM and STACK.

RAM memory consists of 256 general purpose 8bit RAM registers.
All the registers in RAM can be specified by using a decimal address. For example, 0 identifies the first register of RAM.
To read or write RAM registers LOAD instructions must be used. See Table 2.5
Each interrupt level has its own set of flags, which is saved in the STACK together with the Program Counter. These flags are restored from the STACK automatically when a RETI instruction is executed. When the instructions like Interrupt request or CALL are executed, a STACK level is used to push the PC.
The STACK is located in RAM. For each level of stack, 2 bytes of RAM are used. The values of this stack are stored from the last RAM register (address 255). The maximum level of stack must be less than 128.

Figure 2.3 Address Spaces Description


The STACK POINTER indicates the first level available to store data. When a subroutine call or interrupt request occurs, the content of the PC and the current set of flags are stored into the level located by the STACK POINTER.
When a interrupt return occurs (RETI instruction), the data stored in the highest stack level is restored back into the PC and current flags.
Instead, when a subroutine return occurs (RET instruction) the data stored in the highest stack level are restored in the PC not affecting the flags.
These operating modes are illustrated in Figure 2.4.

Note: The user must pay close attention to avoid overwriting RAM locations where the STACK could be stored.

### 2.3.2 Input Registers Bench.

The Input Registers (IR) bench consists of 208 -bit registers containing data or the status of the peripherals.

All the registers can be specified by using a decimal address (for example, 0 identifies the first register of the IR).
The assembler instruction:
LDRI RAM_Reg. IR_i
loads the value of the $i$-th IR in the RAM location identified by the RAM_Reg address.
The first input register is dedicated to store the value of the stack pointer. The next 8 registers (ADC_OUT_0:7) of the IR are dedicated to the 8 converted values deriving from the ADC. The last 9 Input Registers contain data from the I/O ports and PWM/Timers. The following table summarizes the IR address and the relative peripherals. In order to simplify the concept, a mnemonic name is assigned to the registers. The same name is used in VISUALSTUDIO ${ }^{\circledR}$ development tools

Figure 2.4 Stack Operation


Table 2.2 Input Registers

| IR MNEMONIC NAME | PERIPHERAL REGISTER | ADDRESS |
| :---: | :---: | :---: |
| STACK_POINTER | STACK POINTER | 0 |
| CHAN 0 | A/D CHANNEL 0 | 1 |
| CHAN 1 | A/D CHANNEL 1 | 2 |
| CHAN 2 | A/D CHANNEL 2 | 3 |
| CHAN 3 | A/D CHANNEL 3 | 4 |
| CHAN 4 | A/D CHANNEL 4 | 5 |
| CHAN 5 | A/D CHANNEL 5 | 6 |
| CHAN 6 | A/D CHANNEL 6 | 7 |
| CHAN 7 | A/D CHANNEL 7 | 8 |
| PORT_A | PORT A INPUT REGISTER | 9 |
| PORT_B | PORT B INPUT REGISTER | 10 |
| PORT_C | PORT C INPUT REGISTER | 11 |
| PWM_0_COUNT | PWM/TIMER 0 COUNTER | 12 |
| PWM_0_STATUS | PWM/TIMER 0 STATUS REGISTER | 13 |
| PWM_1_COUNT | PWM/TIMER 1 COUNTER | 14 |
| PWM_1_STATUS | PWM/TIMER 1 STATUS REGISTER | 15 |
| PWM_2_COUNT | PWM/TIMER 2 COUNTER | 16 |
| PWM_2_STATUS | PWM/TIMER 2 STATUS REGISTER | 17 |
| SCI_RX | SCI DATA REGISTER | 18 |
| SCI_STATUS | SCI STATUS REGISTER | 19 |

### 2.3.3 Configuration Registers.

The ST52x430 configuration Registers allow the configuration of all the blocks of the fuzzy microcontroller. Table 2.3 describes the functions and the related peripherals of each of the Configuration Registers. By using the load
instructions, the Configuration Registers can be set by using values stored in the Program Memory (EPROM) or in RAM.
Use and meaning of each register will be described in further details in the corresponding section.

Table 2.3 Configuration Registers

| CONFIGURATION REGISTER | PERIPHERAL | DESCRIPTION |
| :---: | :---: | :---: |
| REG_CONF 0 | INTERRUPT MASK | Interrupts mask setting |
| REG_CONF 1 | N.U. | N.U. |
| REG_CONF 2 | WATCHDOG TIMER | Watchdog Timer Configuration |
| REG_CONF 3 | A/D CONVERTER | A/D configuration |

Table 2.3 Configuration Registers (continued)

| CONFIGURATION REGISTER | PERIPHERAL | DESCRIPTION |
| :---: | :---: | :---: |
| REG_CONF 4 | PORT A | Set the relative bit like digital input <br> or digital output |
| REG_CONF 5 | PWM/TIMER 0 | PWM/Timer 0 Working mode <br> Configuration |
| REG_CONF 6 | PWM/TIMER 0 | PWM/TIMER 0 Prescaler <br> configuration and output waveform <br> selection. |
| REG_CONF 7 | PWM/TIMER 0 | PWM/TIMER 0 Working Mode <br> Configuration |
| REG_CONF 8 | PWM/TIMER 1 | PWM/TIMER 1 Working Mode <br> Configuration |
| REG_CONF 9 | PWM/TIMER 1 | PWM/TIMER 1 Prescaler <br> configuration and output waveform <br> selection. |
| REG_CONF 10 | PWM/TIMER 2 | PWM/TMER 2 Working Mode <br> Configuration |
| REG_CONF 12 | PWM/TIMER 2 | PWM/Timer 2 Prescaler <br> configuration and output waveform <br> selection. |
| REG_CONF 13 | PORT A B | Set the bit 0,1 and 2 like Digital I/O <br> or complementary Timers Output. |
| REG_CONF 14 | PORT B | Set the relative bit like digital input <br> or digital output. |
| REG_CONF 15 | PORT C | Set the relative I/O like Digital or <br> Analog. |
| REG_CONF 16 | REG_CONF 17 | Interrupt Priority |

### 2.3.4 Output Registers.

The Output Registers (OR) consist of 10 registers containing data for the microcontroller peripherals including the I/O Ports.
All registers can be specified by using a decimal address (for example, 1 identifies the second OR). By using LOAD instructions the Output Registers (OR) may be set by using values stored in the Program Memory (LDPE) or in RAM (LDPR)
The assembler instruction:
LDPR OR_i RAM_Reg.
loads the value of the RAM location identified by the address RAM_Reg in the OR i-th Table 2.4 describes OR.
In order to simplify the concept, a mnemonic name is assigned to OR. The same names are used in FUZZYSTUDIO ${ }^{\text {TM }} 4.0$ development tools.
Use and meaning of each register will be described in further details in the corresponding section.

Table 2.4 Output Registers

| OR MNEMONIC NAME | PERIPHERAL REGISTER | ADDRESS |
| :---: | :---: | :---: |
| PORT_A | PORT A OR | 0 |
| PORT_B | PORT B OR | 1 |
| PORT_C | PORT C OR | 2 |
| PWM_0_COUNT | TIMER/PWM 0 COUNTER | 3 |
| PWM_0_RELOAD | TIMER/PWM 0 RELOAD REGISTER | 4 |
| PWM_1_RELOAD | TIMER/PWM 1 COUNTER | 5 |
| PWM_2_COUNT | TIMER/PWM 1 RELOAD REGISTER | 7 |
| PWM_2_RELOAD | TIMER/PWM 2 RELOAD REGISTER | 8 |
| SCI_TX_DATA | SCI DATA REGISTER | 9 |

### 2.4 Arithmetic Logic Unit

The 8-bit Arithmetic Logic Unit (ALU) allows the performance of arithmetic calculations and logic instructions, which can be divided into 5 groups: Load, Arithmetic, Jump, Interrupts and Program Control instructions (refer to the ST52x430 Assembler Set for further details).
The computational time required for each instruction consists of one clock pulse for each Cycle plus 3 clock pulses for the decoding phase.

The ALU of the ST52×430 can perform multiplication (MULT) and division (DIV). Multiplication is performed by using 8 bit operands storing the result in 2 registers ( 16 bit values), see Figure 2.5 and Figure 2.6.
WARNING: If the LSB of the multiplication result is 0 , the Zero flag is set although the result is not 0 .

Table 2.5 Load instructions

| Load Instructions |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Mnemonic | Instruction | Bytes | Cycles | $\mathbf{Z}$ | $\mathbf{S}$ | $\mathbf{C}$ |  |
| LDCE | LDCE conf, EPROM | 3 | 17 | - | - | - |  |
| LDCR | LDCR conf, RAM | 3 | 14 | - | - | - |  |
| LDFR | LDFR FUZZY_i_RAM RAM | 3 | 14 | - | - | - |  |
| LDPE | LDPE per, EPROM | 3 | 17 | - | - | - |  |
| LDPE | LDPE per, (RAM) | 3 | 17 | - | - | - |  |
| LDPR | LDPR reg, RAM | 3 | 14 | - | - | - |  |
| LDRC | LDRC RAM, const | 3 | 14 | - | - | - |  |
| LDRE | LDRE RAMi, EPROMi | 3 | 16 | - | - | - |  |
| LDRE | LDRE (RAMi), (RAMj) | 3 | 18 | - | - | - |  |
| LDRI | LDRI RAM, inp_reg | 3 | 15 | - | - | - |  |
| LDRR | LDRR RAMi, RAMj | 3 | 16 | - | - | - |  |

Table 2.5 Load instructions

| PGSET | PGSET const | 2 | 9 | - | - | - |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

Table 2.6 Arithmetic \& Logic instructions set

| Arithmetic Instructions |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Mnemonic | Instruction | Bytes | Cycles | Z | S | C |
| ADD | ADD regi, regj | 3 | 17 | I | - | 1 |
| ADDO | ADDO regi, regj | 3 | 20 | 1 | 1 | 1 |
| AND | AND regi, regj | 3 | 17 | I | - | - |
| ASL | ASL regi | 2 | 15 | 1 | - | 1 |
| ASR | ASR regi | 2 | 15 | 1 | 1 | - |
| DEC | DEC regi | 2 | 15 | 1 | 1 | - |
| DIV | DIV regi, regj | 3 | 26 | 1 | 1 | 1 |
| INC | INC regi | 2 | 15 | 1 | - | 1 |
| MULT | MULT regi, regj | 3 | 19 | 1 | - | - |
| NOT | NOT regi | 2 | 15 | 1 | - | - |
| OR | OR regi, regj | 3 | 17 | 1 | - | - |
| SUB | SUB regi, regj | 3 | 17 | 1 | 1 | - |
| SUBO | SUBO regi, regj | 3 | 20 | 1 | 1 | 1 |
| MIRROR | MIRROR regi | 2 | 15 | 1 | - | - |

Table 2.7 Jump Instruction Set

| Jump instructions |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mnemonic | instruction | bytes | cycles | $\mathbf{z}$ | $\mathbf{s}$ | c |  |
| call | call addr | 3 | 18 | - | - | - |  |
| jp | jp addr | 3 | 12 | - | - | - |  |
| jpc | jpc addr | 3 | $10 / 12$ | - | - | - |  |
| jpnc | jpnc addr | jpns addr | 3 | $10 / 12$ | - | - |  |
| jpns | jpnz addr | 3 | $10 / 12$ | - | - | - |  |
| jpnz | jps addr | 3 | $10 / 12$ | - | - | - |  |
| jps | jpz addr | 3 | $10 / 12$ | - | - | - |  |
| jpz | ret | 3 | $10 / 12$ | - | - | - |  |
| ret |  | 1 | 13 | - | - | - |  |

Table 2.8 Interrupt Instructions Set

| Interrupt Instructions |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Mnemonic | Instruction | Bytes | Cycles | $\mathbf{Z}$ | $\mathbf{S}$ | C |  |
| HALT | HALT | 1 | $7 / 15$ | - | - | - |  |
| MEGI | MEGI | 1 | $7 / 15$ | - | - | - |  |

Table 2.8 Interrupt Instructions Set (continued)

| MDGI | MDGI | 1 | 6 | - | - | - |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RETI | RETI | 1 | 12 | - | - | - |
| RINT | RINT INT | 2 | 8 | - | - | - |
| UDGI | UDGI | 1 | 6 | - | - | - |
| UEGI | UEGI | 1 | $7 / 15$ | - | - | - |
| WAITI | WAITI | 1 | $7 / 14$ | - | - | - |

Table 2.9 Control Instructions Set

| Control Instructions |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Mnemonic | Instruction | Bytes | Cycles | $\mathbf{Z}$ | $\mathbf{S}$ | $\mathbf{C}$ |  |
| FUZZY | FUZZY | 1 | 5 | - | - | - |  |
| NOP | NOP | 1 | 6 | - | - | - |  |
| WDTRFR | WDTRFR | 1 | 7 | - | - | - |  |
| WDTSLP | WDTSLP | 1 | 6 | - | - | - |  |

Notes:
I affected

- not affected

Figure 2.5 Multiplication


Figure 2.6 Division


## 3 EPROM

EPROM memory provides an on-chip userprogrammable non-volatile memory, which allows fast and reliable storage of user data.
EPROM memory can be locked by the user. In fact, a memory location called Lock Cell is devoted to lock EPROM and avoid external operations. A software identification code, called ID CODE, distinguishes which software version is stored in the memory.
64 kbits of memory space with an 8-bit internal parallelism (up to 8 kbytes) addressed by an 13-bit bus are available. The data bus is 8 bits.
Memory has a double supply: $\mathrm{V}_{\mathrm{PP}}$ is equal to $12 \mathrm{~V} \pm 5 \%$ in Programming Phase or to $\mathrm{V}_{\text {SS }}$ during Working Phase. $\mathrm{V}_{\mathrm{DD}}$ is equal to $5 \mathrm{~V} \pm 10 \%$.
ST52x430 EPROM memory is divided into three main blocks (see Figure ):

- Interrupt Vectors memory block (3 through 20) contains the addresses for the interrupt routines. Each address is composed of three bytes.
- Mbfs Setting memory block (21 through MemAdd) contains the coordinates of the vertexes of every Mbf defined in the program.
- The maximum value of MemAdd is 1023. This area is dynamically assigned according to the size of the fuzzy routines. The unused memory area, if any, is assigned to the Program Instruction Set memory block.
- The Program Instructions Set memory block (MemAdd through MemAddx) contains the instruction set of the user program. The following table summarizes the values of Mem Addx for the different devices

Table 3.1 Mem Addx

|  | ST52T430K1 | ST52T430 | ST52T430 |
| :---: | :---: | :---: | :---: |
| Me <br> m | 2047 | 4095 | 8191 |

Locations 0,1 and 2 contain the address of the first microcode instruction. The operations that can be performed on EPROM during the Programming Phase are: Stand By, Memory Writing, Reading and Verify/Margin Mode, Memory Lock, IDCode Writing and Verify.

Figure 3.1 Program Memory Organization

Table 3.2 EPROM Control Register

| OPERATION | REGISTER VALUE |
| :---: | :---: |
| Stand By | 0 |
| Memory Reading/Verify | 1 |
| Memory Unlock and <br> Lock Status Reading | 2 |
| Memory Writing | 3 |
| Memory Lock | 4 |
| ID CODE Writing | 5 |
| Memory Lock Status <br> Reading/Verify | 9 |
| ID CODE Reading/ <br> Verify | 10 |

Figure 3.2 Eprom Programming Timing

The operations above are managed by using the internal 4-bit EPROM Control Register. The reading phase is executed with $\mathrm{V}_{\mathrm{PP}}=5 \mathrm{~V} \pm 5 \%$, while the verify/Margin Mode phase needs $\mathrm{V}_{\mathrm{PP}}=$ $12 \mathrm{~V} \pm 5 \%$. The Blank Check must be a reading operation with $\mathrm{V}_{\mathrm{PP}}=5 \mathrm{~V} \pm 5 \%$.
Table 3.2 illustrates EPROM Control Register codes used to identify the operation running.

### 3.1 EPROM Programming Phase Procedure

The Programming mode is selected by applying $12 \mathrm{~V} \pm 5 \%$ voltage or $5 \mathrm{~V} \pm 5 \%$ voltage to the $\mathrm{V}_{\mathrm{PP}}$ pin and setting the control signal as following:
RESET =Vss
TEST =Vss
If the $\mathrm{V}_{\mathrm{PP}}$ voltage is $5 \mathrm{~V} \pm 5 \%$ only reading may be performed.
RST_ADD, INC_ADD, RST_CONF, INC_CONF and $\overline{\mathrm{P}} \mathrm{HASE}$ are the control signals used during the Programming Mode.
PHASE, RST_CONF and RST_ADD signals are active on level, the others are active on rising edge.


PHASE and RST_ADD signals are active low, RST_CONF signal is active high.
Port A is used for the memory data I/O. (See Table 3.2 for pin reference on the different packages).

Memory may be locked by means of the Memory Lock Status, which is a flag used to enable EPROM operations.
If Memory Lock Status is 1 all EPROM operations are enabled, otherwise the user may only read (and verify) the OTP code and the Memory Lock Status.
Only if EPROM is not locked by means of Lock Cell (see EPROM Locking may EPROM operations be enabled by changing the Memory Lock Status from 0 to 1.
RST_ADD signal resets the memory address register and the Memory Lock Status. When the RST_ADD becomes high, the memory must be unlocked in order to read or write.
INC_ADD signal increments the memory address.
RST_CONF signal resets the EPROM Control
Register. When RST_CONF is high, the DATA I/ O Port A is in output, otherwise it is always in input.
INC_CONF signal increments the EPROM Control Register value.
PHASE signal validates the operation selected by means of the EPROM Control Register value.

### 3.1.1 EPROM Operation.

In order to execute an EPROM operation (See Table 3.2), the corresponding identification value must be loaded in the EPROM Control Register. The signal timing is the following: RST_ADD= high and PHASE= high, RST_CONF changes from low to high level, to reset the EPROM Control Register, and INC_CONF signal generates a number of positive pulses equal to the value to be loaded. After this sequence, a negative pulse of the PHASE signal will validate the operation selected. The minimum PHASE signal pulse width must be $10 \mu \mathrm{~s}$ for EPROM Writing Operation and 100 ns for the others.
When RST_CONF is high, DATA I/O Port A is enabled in output and the reading/verifying operation results are available.
After a writing operation, when RST_CONF is high, Port A is in output without valid data.

### 3.1.2 EPROM Locking.

The Memory Lock operation, which is identified with the number 4 in the EPROM Control Register, writes " 0 " in the Memory Lock Cell.
At the beginning of an External Operation, when the RST_ADD signal changes from low level to high level, the Memory Lock Status is " 0 ", therefore it must be unlocked before proceeding.
In order to unlock the Memory Lock Status the operation, which is identified by the number 2 in the EPROM Control Register must be executed (see Figure 3.2).
Memory Lock Status can be changed only if Memory Lock Cell is " 1 ". After a Memory Lock operation external operations cannot be executed except to read (or verify) the OTP Code and the Memory Lock Status.

### 3.1.3 EPROM Writing.

When the memory is blank, all bits are at logic level " 1 ". Data is introduced by programming only the zeros in the desired memory location. However, all input data must contain both " 1 " and " 0 ".
The only way to change " 0 " into " 1 " is to erase the entire memory (by exposure to Ultra Violet light) and reprogram it.
The memory is in Writing mode when the EPROM Control Register value is 3 .
The $\mathrm{V}_{\mathrm{PP}}$ voltage must be $12 \mathrm{~V} \pm 5 \%$, with stable data on the data bus $\operatorname{PA}(0: 7)$.
The timing signals are the following (see Figure ):

1) RST_ADD and RST_CONF change from low to high level,
2) two pulses on INC_CONF signal load the Memory Unlock operation code,
3) a negative pulse ( 100 ns ) on the PHASE signal validates the Memory Unlock operation,
4) a negative pulse on RST_CONF signal resets the EPROM Control Register,
5) three positive pulses on INC_CONF load the Memory Writing operation code,
6) a train of positive pulses on INC_ADD signal increments the memory location address up to the requested value (generally this is a sequential operation and only one pulse is used),
7) a negative pulse ( $10 \mu \mathrm{~s}$ ) on the PHASE signal validates the Memory Writing operation.

### 3.1.4 EPROM Read/Verify Margin Mode.

The read phase is executed with $\mathrm{V}_{\mathrm{PP}}=5 \mathrm{~V} \pm 5 \%$, instead of the verify phase that needs $\mathrm{V}_{\mathrm{PP}}=$ $12 \mathrm{~V} \pm 5 \%$.
The Memory Verify operation is available in order to verify the accuracy of the data written. A Memory Verify Margin Mode operation can be executed immediately after writing each byte, in this case (see Figure):

1) a positive pulse on RST_CONF signal resets the EPROM Control Register, if it wasn't already reset;
2) one positive pulse on INC_CONF loads the Memory Read/Verify operation code;
3) a negative pulse ( 100 ns ) on the PHASE signal validates the Memory Reading / Verify operation;
4) a negative pulse on RST_CONF signal puts in the $\mathrm{PA}(0: 7)$ port the value stored in the actual memory address and resets the EPROM Control Register;

If an error occurred writing, the user has to repeat EPROM writing.

### 3.1.5 Stand by Mode.

EPROM has a standby mode, which reduces the active current from 10 mA (Programming mode) to less than $100 \mu \mathrm{~A}$. Memory is placed in standby mode by setting the PHASE signal at a high level or when the EPROM Control Register value is 0 and the PHASE signal is low.

### 3.1.6 ID code.

A software identification code, called ID code may be written in order to distinguish which software version is stored in the memory.
64 Bytes are dedicated to store this code by using the address values from 0 to 63 .
The ID Code may be read or verified even if the Memory Lock Status is " 0 ".
The timing signals are the same as that of a normal operation.

### 3.2 Eprom Erasure

The transparent window available in the CSDIP32W package, allows the memory contents to be erased by exposure to UV light.
Erasure begins when the device is exposed to light with a wavelength shorter than 4000A. Sunlight, as well as some types of artificial light, includes wavelengths in the $3000-4000 \AA$ range which, on prolonged exposure can cause erasure of memory contents. Therefore, it is recommended that EPROM devices be fitted with an opaque label over the window area in order to prevent unintentional erasure.
The erasure procedure recommended for EPROM devices consists of exposure to short wave UV light having a wavelength of 2537A. The minimum integrated dose recommended (intensity x exposure time) for complete erasure is $15 \mathrm{Wsec} / \mathrm{cm} 2$.
This is equivalent to an erasure time of $15-20$ minutes using a UV source having an intensity of $12 \mathrm{~mW} / \mathrm{cm} 2$ at a distance of 25 mm ( 1 inch ) from the device window.

## 4 INTERRUPTS

The Control Unit (CU) responds to peripheral events and external events via its interrupt channels.
When such an events occur, if the related interrupt is not masked and according to a priority order, the current program execution can be suspended to allow the CU to execute a specific response routine.
Each interrupt is associated with an interrupt vector that contains the memory address of the related interrupt service routine. Each vector is located in the Program Space (EPROM Memory) at a fixed address (see Interrupt Vectors Table 4.2).

### 4.1 Interrupt Operation

If there are pending interrupts at the end of an arithmetic or logic instruction, the one with the highest priority is passed. Passing an interrupt means storing the arithmetic flags and the current PC in the stack and executing the associated Interrupt routine, whose address is located in three bytes of the EPROM memory location between address 3 and 20.
The Interrupt routine is performed as a normal code, checking if a higher priority interrupt has to be passed at the end of each instruction. An Interrupt request with the higher priority stops the lower priority Interrupt. The Program Counter and the arithmetic flags are stored in the stack.
With the RETI (Return from Interrupt) instruction the arithmetic flags and Program Counter (PC) are restored from the top of the stack. This stack was already described in section RAM and STACK.
An Interrupt request cannot stop processing of the fuzzy rule, but this is passed only after the end of a fuzzy rule or at the end of a logic, or arithmetic instruction.
NOTE: A fuzzy routine can only be interrupted in the Main program. An interrupt request cannot stop a Fuzzy function that is running inside another interrupt routine. In order to use a Fuzzy function inside an interrupt routine, the user MUST include the Fuzzy function between an UDGI (MDGI) instruction and an UEGI (MEGI) instruction (see the following paragraphs), so that the interrupt request may be disabled during the execution of the fuzzy function.

### 4.2 Global Interrupt Request Enabling

When an Interrupt occurs, it generates a Global Interrupt Pending (GIP), that can be masked by software. After a GIP a Global Interrupt Request (GIR) will be generated and Interrupt service

Figure 4.1 Interrupt Flow


Figure 4.2 Interrupt Vectors mapping


Figure 4.3 Global Interrupt Request generation


Routine associated to the interrupt with higher priority will start.
In order to avoid possible conflicts between interrupt masking set in the main program, or inside high level language compiler macros, the GIP is hung up through the User Global Interrupt Mask or the Macro Global Interrupt Mask (see Figure 4.2).
UEGI/UDGI instruction switches on/off the User Global Interrupt Mask, enabling/disabling the GIR for the main program.
MEGI/MDGI instructions switch the Macro Global Interrupt Mask on/off, in order to ensure that the macro will not be broken.

### 4.3 Interrupt Sources

ST52×430 manages interrupt signals generated by the internal peripherals (PWM/Timers, UART and Analog to Digital Converter) or coming from the INT/PC0 pin. The External Interrupt can be programmed to be active on the rising or falling edge of INT/PC0 signal by setting the PEXTINT bit of the Configuration Register to 0 .
WARNING: Changing the interrupt priority an interrupt request is generated.
Each peripheral can be programmed in order to generate the associated interrupt; further details are described in the related chapter.

### 4.4 Interrupt Maskability

The interrupts can be masked by configuring the REG_CONF 0 by means of LDCR, or LDCE, instruction. The interrupt is enabled when the bit associated to the mask interrupt is " 1 ". Viceversa, when the bit is " 0 ", the interrupt is masked and is kept pendent.
For example:
LDRC 10,6 //load the constant 6 in the RAM Register 10
LDCR 0, 10 // set the CONF_REG 0 with the value stored in the RAM Register 10
the result is CONF_REG0 $=00000110$ enabling the interrupts deriving from the ADC (INT_ADC) and from the PWM/TIMER 0 (INT_PWM/TIMERO).

Table 4.1 Configuration Register 0 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | MSKE | 0 | External Interrupt Masked |
|  |  | 1 | External Interrupt Not Masked |
| 1 | MSKAD | 0 | A/D Converter Interrupt Masked |
|  |  | 1 | A/D Converter Interrupt Not Masked |
| 2 | MSKTM0 | 0 | PWM/TIMER OInterrupt Masked |
|  |  | 1 | PWM/TIMER 0 Interrupt Not Masked |
| 3 | MSKTM1 | 0 | PWM/TIMER 1 Interrupt Masked |
|  |  | 1 | PWM/TIMER 1 Interrupt Not Masked |
| 4 | MSKTM2 | 0 | PWM/TIMER 2 Interrupt Masked |
|  |  | 1 | PWM/TIMER 2 Interrupt Not Masked |
| 5 | MSCI | 0 | SCI Interrupt Masked |
|  |  | 1 | SCI Interrupt Not Masked |
| 6 | PEXTINT | 0 | External Interrupt Polarity Active on Rising |
|  |  | 1 | External Interrupt Polarity <br> Active on Falling |
| 7 | Not used |  |  |

Reset Configuration '000000'

Table 4.2 Interrupts Description

| Name | Description |  | Priority | Peripheral <br> Code | Maskable | EPROM <br> Locations |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INT_ADC | ADC | Int | Programmable | 000 | yes | $3-5$ |
| INT_PWM/ <br> TIMER0 | PWM/TIMER 0 | Int | Programmable | 001 | yes | $6-8$ |
| INT_PWM/ <br> TIMER1 | PWM/TIMER 1 | Int | Programmable | 010 | yes | $9-11$ |
| INT_PWM/ <br> TIMER2 | PWM/TIMER 2 | Int | Programmable | 011 | yes | $12-14$ |
| INT_SCI | SCI | Int | Programmable | 100 | yes | $15-17$ |
| INT_EXT | External <br> Interrupt (INT) | Ext | Highest | - | yes | $18-20$ |

Figure 4.4 Interrupt Configuration Register 0

## REG_CONFO

Interrupts Mask


MSKE: Ext. Int. MSKAD: A/D Int.
MSKTMO: Timer0 Int.
MSKTM1: Timer1 Int.
MSKTM2: Timer2 Int.
MSCI: SCI Int.
PEXTINT: Ext. Int. Polariry Not Used

Figure 4.5 Interrupt Configuration Register 17 \& 18


### 4.5 Interrupt Priority

Seven priority levels are available: level 6 has the lowest priority, level 0 has the highest priority.
Level 6 is associated to the Main Program, levels 5 to 1 are programmable by means of the priority registers called REG_CONF17 and REG_CONF18 (see Figure 4.5 and Table 4.3); whereas the higher level is related to the external interrupt (INT_EXT).
PWM/Timers, UART and ADC are identified by a three-bit Peripheral Codes (see Table 4.2); in order to set the $i$-th priority level the user must write the peripheral label $i$ in the related INTi priority level.
i.e.

LDRC 10, 193 //(load the value 193=' 11000001 ' in the RAM Register 10)
LDRC 11, 168 //(load the value 168=' $10101000^{\prime}$ in the RAM Register 11)
LDCR 17, 10 // set the REG_CONF17= '11000001'
LDCR 18, 11 // set the REG_CONF18= '10101000'
The following priority levels are defined:
■ Level 1: INT_PWM/TIMER0 (PWM/TIMER 0 Code: 001)
■ Level 2: INT_ADC (ADC Code: 000)

Table 4.3 Conf. Register 17 \& 18 Description

| Bit | Name | Value | Level |
| :---: | :---: | :---: | :---: |
| $0,1,2$ | INT1 | Periphera <br> I Code | High |
| $3,4,5$ | INT2 | Periphera <br> I Code | Medium-High |
| $6,7,8$ | INT3 | Periphera <br> I Code | Medium-Low |
| $9,10,11$ | INT4 | Periphera <br> I Code | Low |
| $12,13,1$ | INT5 | Periphera <br> I Code | Very Low |
| 4 |  |  |  |

■ Level 3: Int_PWM/Timer2 (PWM/TIMER 2 Code: 011)
■ Level 4: INT_UART (UART Code: 100)

- Level 5: INT_PWM/TIMER1 (PWM/TIMER 1

Code: 010)

Figure 4.6 Example of a sequence of Interrupt requests


REMARK: The Interrupt priority must be set at the beginning of the main program, because at the RESET REG_CONF1='00000000', this condition could generate wrong operations. Further, changing the priority levels must be avoided in interrupt service routines.

When a source provides an Interrupt request and the request processing is also enabled, the CU changes the normal sequential flow of a program by transferring program control to a selected service routine.
When an interrupt occurs the CU executes a JUMP instruction to the address loaded in the related location of the Interrupt Vector.
When the execution returns to the original program it immediately begins following the instruction that was interrupted.

Table 4.4 RINT Instruction code

| Peripheral Name | Value |
| :---: | :---: |
| A/D Converter | 0 |
| PWM/TIMER 0 | 1 |

### 4.6 Interrupts and Low power mode

All interrupts allow the processor to leave the WAIT low power mode. Only the external Interrupt allows the processor to leave the HALT low power mode.

### 4.7 Interrupt RESET

An eventually pending interrupt can be reset with the instruction RINT $j$, which resets the interrupt $j$-th where $j$ identifies the peripherals as described in the following table (see Table 4.4).
The assembler instruction:
RINT 2
Resets the PWM/Timer 1 interrupt.
Note: The RINT command must be preceded from a UDGI (or MDGI) command and followed by a UEGI (or MEGI) command.

WARNING: If an interrupt is reset, with the RINT instruction within its own interrupt routine, the priority level of the interrupt becomes the lowest and the routine can be immediately interrupted by a lower priority interrupt request.

## 5 CLOCK, RESET \& POWER SAVING MODE

### 5.1 System Clock

The ST52x430 Clock Generator module generates the internal clock for the internal Control Unit, ALU and on-chip peripherals and it is designed to require a minimum number of external components.
The ST52x430 oscillator circuit generates an internal clock signal with the same period and phase as that of the OSCin input pin. The maximum frequency allowed is $\mathbf{2 0} \mathbf{~ M h z}$.
Note: When the SCI peripheral is used only a 5, 10, or $\mathbf{2 0} \mathbf{~ M H z ~ s y s t e m ~ c l o c k ~ m u s t ~ b e ~ u s e d . ~}$
The system clock may be generated by using either a quartz crystal, ceramic resonator or an external clock.
The different methods of the clock generator are illustrated in Figure 5.1.
When an external clock is used, it must be connected on the OSCin pin, while OSCout can be floating.
The crystal oscillator start-up time is a function of many variables: crystal parameters (especially $\mathrm{R}_{\mathrm{s}}$ ), oscillator load capacitance (CL), IC parameters, environment temperature, supply voltage.

Figure 5.1 Oscillator Connections

Note: The crystal or ceramic leads and circuit connections must be as short as possible. Typical values for CL1, CL2 are 10 pF for a 20 MHz crystal.

### 5.2 RESET

There are two Reset sources:

- RESET pin (external source.)
- WATCHDOG (internal source)

When a Reset event happens, the user program restarts from the beginning.
The Reset pin is an input. An internal reset does not affect this pin.
A Reset signal originated by external sources is recognized instantaneously. The RESET pin may be used to ensure $V_{D D}$ has risen to a point where the MCU can operate correctly before the user program runs. In working mode Reset must be set to '1' (see Table 2.1).

### 5.3 Power Saving Mode

There are two Power Saving modes: WAIT and HALT mode. These conditions may be entered using the WAIT or HALT instructions.

### 5.3.1 Wait Mode

Wait mode places the MCU in low power consumption by stopping the CPU. All peripherals

and the watchdog remain active. During WAIT mode, Interrupts are enabled. The MCU will remain in Wait mode until an Interrupt or a RESET occurs, whereupon the Program Counter jumps to the interrupt service routine or, if a RESET occurs, at the beginning of the user program.
REMARK: In Wait mode the CPU clock does not stop.

### 5.3.2 Halt Mode

Halt mode is MCU's lowest power consumption mode, which is entered by executing the HALT instruction. The internal oscillator is turned off, causing all internal processing to stop, including the operations of the on-chip peripherals.

Figure 5.2 Reset Block Diagram


Figure 5.3 Simple Reset Circuit


Halt mode cannot be used when the watchdog is enabled.
If the HALT instruction is executed while the watchdog system is enabled, it will be skipped without modifying the normal CPU operations.
The ICU can exit Halt mode after an external interrupt or reset. The oscillator is then turned on and stabilization time is provided before restarting CPU operations. Stabilization time is 4096 CPU clock cycles after the interrupt and 1.000.000 after the Reset.
After the start up delay, the CPU restarts operations by serving the external interrupt routine. Reset makes the ICU exit from HALT mode and restart, after the delay, from the beginning of the user program after the delay.
Warning: if the External Interrupt is disabled, the ICU exits from the Halt mode and jumps to the lower priority interrupt routine.

Figure 5.4 WAIT Flow Chart


Figure 5.5 HALT Flow Chart


## 6 I/O PORTS

### 6.1 Introduction

ST52x430 devices feature flexible individually programmable multi-functional input/output lines. Refer to the following figure for specific pin allocations.
23 I/O lines, grouped in 3 different ports are available on the ST52×430:
PORT A = 7 or 8 -bit ports (PA0-PA7 pins)
PORT B = 7 or 8 -bit ports (PB0-PB7 pins)
PORT C $=8$-bit port (PC0 - PC7 pins)
PIN 24 in the SO34 or PIN 22 in the PDIP32 can be configured to belong to port A or to port B.
These I/O lines can be programmed to provide digital input/output and analog input, or to connect input/output signals to the on-chip peripherals as alternate pin functions.
Input buffers are TTL compatible with Schmitt trigger in port $A$ and $C$ while port $B$ is CMOS compatible without Schmitt trigger.
The output buffer can supply up to 8 mA .
The port cannot be configured to be used contemporaneously as input and output.

Each port is configured by using two configuration registers. The first is used to determine if a pin is an input or output, while the second defines the Alternate functions.

### 6.2 Input Mode

The input configuration is selected by setting the corresponding configuration register bit to "1" (REG_CONF 4, 13 and 15) (see paragraph I/O Port Configuration Registers). The ports are configured by using the configuration registers illustrated in the following table.

Table 6.1 I/O Port Configuration Registers.

| PORT A | PORT B | PORT C |
| :---: | :---: | :---: |
| Reg_Conf 4 | Reg_Conf 13 | Reg_Conf 15 |

Digital input data is automatically stored in the Input Registers, but it cannot be read directly. In order to read a single bit of the IR its value must be copied in a RAM location. Digital data is stored in a RAM location by using the assembler instruction:
LDRI RAM_Reg Input_i

Figure 6.1 Ports A \& C Functional Blocks


Figure 6.2 Port B Functional Blocks


Table 6.2 Input Register and I/O Ports

| PORT A | PORT B | PORT C |
| :---: | :---: | :---: |
| IR 9 | IR 10 | IR 11 |

### 6.3 Output Mode

The output configuration is selected by setting the corresponding configuration register bit to "0" (REG_CONF 4, 13 and 15) (see paragraph I/O Port Configuration Registers).
Digital data is transferred to the related I/O Port by means of the Output register via the assembler instructions LDPE or LDPR.

Table 6.3 Output Register and I/O Ports

| PORT A | PORT B | PORT C |
| :---: | :---: | :---: |
| OR 0 | OR 1 | OR 2 |

### 6.4 Alternate Functions

Several ST52×430 pins are configurable to be used with different functions (see Table 1.1).
When an on-chip peripheral is configured to use a pin, the correct I/O mode of the related pin must be selected.
For example: if pin 26 (PA5/TOCLK in the SO34) has to be used as an external PWM/Timer0 clock, the Reg_Conf 4(5) bit must be set to ' 1 '.
When the signal is an on-chip peripheral input the related I/O pin has to be configured in Input Mode.
When a pin is used as an A/D Converter input the related I/O pin is automatically set in tristate. The analog multiplexer (controlled by the A/D configuration Register) switches the analog voltage present on the selected pin to the common analog rail, which is connected to the ADC input.
It is recommended that the voltage level not be changed or that any port pins not be loaded while conversion is running. Furthermore, it is recommended that clocking pins not be located close to a selected analog pin.

### 6.5 I/O Port Configuration Registers

The I/O mode for each bit of the three ports is selected by using the Configuration Registers 4,

13 and 15 (See Table 6.1) The structure of these registers is illustrated in the following tables.
Each bit of the configuration registers determines the I/O mode of the related port pin.

Table 6.4 Ports A REG_CONF 4

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | D0 | 0 | Set the pin PA0/TORES in Output Mode |
|  |  | 1 | Set the pin PA0/TORES in Input Mode |
| 1 | D1 | 0 | Set the pin PA1/T0OUT in Output Mode |
|  |  | 1 | Set the pin PA1/T0OUT in Input Mode |
| 2 | D2 | 0 | Set the pin PA2/T1OUT in Output Mode |
|  |  | 1 | Set the pin PA2/T1OUT in Input Mode |
| 3 | D3 | 0 | Set the pin PA3/T2OUT in Output Mode |
|  |  | 1 | Set the pin PA3/T2OUT in Input Mode |
| 4 | D4 | 0 | Set the pin PA4/T0STRT in Output Mode |
|  |  | 1 | Set the pin PA4/T0STRT in Input Mode |
| 5 | D5 | 0 | Set the pin PA5/T0CLK in Output Mode |
|  |  | 1 | Set the pin PA5/T0CLK in Input Mode |
| 6 | D6 | 0 | Set the pin PA6 in Output Mode |
|  |  | 1 | Set the pin PA6 in Input Mode |
| 7 | D7 | 0 | Set the pin PB7/PA7/ Ain7 in Output Mode |
|  |  | 1 | Set the pin PB7/PA7/ Ain7 in Input Mode |
| Reset Configuration '11111111' |  |  |  |

Table 6.5 Ports B REG_CONF 13

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | D0 | 0 | Set the pin PBO/Ain0 in Output Mode |
|  |  | 1 | Set the pin PB0/Ain0 in Input Mode |
| 1 | D1 | 0 | Set the pin PB1/Ain1 in Output Mode |
|  |  | 1 | Set the pin PB1/Ain1 in Input Mode |
| 2 | D2 | 0 | Set the pin PB2/Ain2 in Output Mode |
|  |  | 1 | Set the pin PB2/Ain2 in Input Mode |
| 3 | D3 | 0 | Set the pin PB3/Ain3 in Output Mode |
|  |  | 1 | Set the pin PB3/Ain3 in Input Mode |
| 4 | D4 | 0 | Set the pin PB4/Ain4 in Output Mode |
|  |  | 1 | Set the pin PB4/Ain4 in Input Mode |
| 5 | D5 | 0 | Set the pin PB5/Ain5 in Output Mode |
|  |  | 1 | Set the pin PB5/Ain5 in Input Mode |
| 6 | D6 | 0 | Set the pin PB6/Ain6 in Output Mode |
|  |  | 1 | Set the pin PB6/Ain6 in Input Mode |
| 7 | D7 | 0 | Set the pin PB7/PA7/ Ain7 in Output Mode |
|  |  | 1 | Set the pin PB7/PA7/ Ain7 in Input Mode |
| Reset Configuration '11111111' |  |  |  |

Table 6.6 Port C REG_CONF 15

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | D0 | 0 | Set the pin INT/PC0 in Output Mode |
|  |  | 1 | Set the pin INT/PCO in Input Mode |
| 1 | D1 | 0 | Set the pin T0OUT/ PC1 in Output Mode |
|  |  | 1 | Set the pin T0OUT/ PC1 in Input Mode |
| 2 | D2 | 0 | Set the pin T1OUT/ PC2 in Output Mode |
|  |  | 1 | Set the pin T1OUT/ PC2 in Input Mode |
| 3 | D3 | 0 | Set the pin T2OUT/ PC3 in Output Mode |
|  |  | 1 | Set the pin T2OUT/ PC3 in Input Mode |
| 4 | D4 | 0 | Set the pin Tx/PC4 in Output Mode |
|  |  | 1 | Set the pin Tx/PC4 in Input Mode |
| 5 | D5 | 0 | Set the pin Rx/PC5 in Output Mode |
|  |  | 1 | Set the pin Rx/PC5 in Input Mode |
| 6 | D6 | 0 | Set the pin PC6 in Output Mode |
|  |  | 1 | Set the pin PC6 in Input Mode |
| 7 | D7 | 0 | Set the pin PC7 in Output Mode |
|  |  | 1 | Set the pin PC7 in Input Mode |
| Reset Configuration '11111111' |  |  |  |

Analog Input Option. The PB0-PB7 pins can be configured to be analog inputs according to the codes programmed in the configuration register REG_CONF 14 (See Table 6.7). These analog inputs are connected to the on-chip 8-bit Analog to Digital Converter.

Table 6.7 Analog Inputs (REG_CONF 14)

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | D0 | 0 | pin PB0/Ain0 Digital I/O |
|  |  | 1 | pin PB0/Ain0 Analog |
| 1 | D1 | 0 | pin PB1/Ain1 Digital I/O |
|  |  | 1 | pin PB1/Ain1 Analog |
| 2 | D2 | 0 | pin PB2/Ain2 Digital I/O |
|  |  | 1 | pin PB2/Ain2 Analog |
| 3 | D3 | 0 | pin PB3/Ain3 Digital I/O |
|  |  | 1 | pin PB3/Ain3 Analog |
| 4 | D4 | 0 | pin PB4/Ain4 Digital I/O |
|  |  | 1 | pin PB4/Ain4 Analog |
| 5 | D5 | 0 | pin PB5/Ain5 Digital 1/O |
|  |  | 1 | pin PB5/Ain5 Analog |
| 6 | D6 | 0 | pin PB6/Ain6 Digital I/O |
|  |  | 1 | pin PB6/Ain6 Analog |
| 7 | D7 | 0 | pin PB7/Ain7 Digital I/O |
|  |  | 1 | pin PB7/Ain7 Analog |
| Reset Configuration '11111111' |  |  |  |

## PWM/Timers Alternate Functions

The pins of Port A and C can be configured to be I/ O of the three PWM/Timers available on the ST52x430. The configuration of these pins is performed by using the Configuration Registers REG_CONF 12 and REG_CONF 16 if the related pin has to be output. When the related pin has to be used as an input peripheral the configuration is performed by the relative peripheral configuration registers (See PWM/Timer Session).

Table 6.8 PWM/Timers REG_CONF 16

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | PC1 | 1 | Pin T0OUT/PC1 is configured as Port C Digital I/O |
|  |  | 0 | Pin T0OUT/PC1 is configured as PWM/ Timer 0 output TOOUT |
| 1 | PC2 | 1 | PinT1OUT/PC2 is configured as Port C Digital I/O |
|  |  | 0 | Pin T1OUT/PC2 is configured as PWM/ Timer 1 output T1OUT |
| 2 | PC3 | 1 | Pin T2OUT/PC3 is configured as Port C Digital I/O |
|  |  | 0 | Pin T2OUT/PC3 is configured as PWM/ Timer 2 output T2OUT |
| 3 | PC4 | 1 | Pin Tx/PC4 is configured as Port C Digital I/O |
|  |  | 0 | Pin Tx/PC4 is configured as SCI output Tx |
| 4-7 | NC | X | Not Used |
| Reset Configuration '1111' |  |  |  |

Table 6.9 PWM/Timers REG_CONF 12

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | PA1 | 1 | Pin PA1/TOOUT is configured as PWM/Timer 0 complementary output |
|  |  | 0 | Pin PA1/T0OUT is configured as Port A Digital I/O |
| 1 | PA2 | 1 | Pin PA2/T1OUT is configured as PWM/Timer 1 complementary output |
|  |  | 0 | Pin PA2/T1OUT is configured as Port A Digital I/O |
| 2 | PA3 | 1 | Pin PA3/T2OUT is configured as PWM/Timer 2 complementary output |
|  |  | 0 | Pin PA3/T2OUT is configured as Port A Digital I/O |
| 3 | PASZ | 1 | PORT A bits $=8$ |
|  |  | 0 | PORT A bits $=7$ |
| 4-7 | NC | x | Not Used |
| Reset Configuration '0000' |  |  |  |

Figure 6.3 Configuration Register 12

REG_CONF 12
DIGITAL PORT

## D7 D6 D5 D4 D3 D2 D1 D0

PA1T: Pin PA1/TOOUT setting PA2T: Pin PA2/T1OUT setting
PA3T: Pin PA3/T2OUT setting
PA78: PORT A size
not used

Figure 6.4 Configuration Register 16


## 7 FUZZY COMPUTATION (DP)

The ST52T430/E430 Decision Processor (DP) main features are:
■ Up to 8 Inputs with 8-bit resolution;

- 1 Kbyte of Program/Data Memory available to store more than 300 to Membership Functions (Mbfs) for each Input;
- Up to 128 Outputs with 8-bit resolution;
- Possibility of processing fuzzy rules with an UNLIMITED number of antecedents;
- UNLIMITED number of Rules and Fuzzy Blocks.

The limits on the number of Fuzzy Rules and Fuzzy program blocks are only related to the Program/Data Memory size.

### 7.1 Fuzzy Inference

The block diagram shown in Figure 7.1 describes the different steps performed during a Fuzzy algorithm. The ST52T430/E430 Core allows for the implementation of a Mamdani type fuzzy inference with crisp consequents. Inputs for fuzzy inference are stored in 8 dedicated Fuzzy input registers. The LDFR instruction is used to set the Input Fuzzy registers with values stored in the Register File. The result of a Fuzzy inference is stored directly in a location of the Register File.

### 7.2 Fuzzyfication Phase

In this phase the intersection (alpha weight) between the input values and the related Mbfs (Figure 7.2) is performed.
Eight Fuzzy Input registers are available for Fuzzy inferences.

Figure 7.2 Alpha Weight Calculation


After loading the input values by using the LDFR assembler instruction, the user can start the fuzzy inference by using the FUZZY assembler instruction. During fuzzyfication: input data is transformed in the activation level (alpha weight) of the Mbf's.

### 7.3 Inference Phase

The Inference Phase manages the alpha weights obtained during the fuzzyfication phase to compute the truth value $(\omega)$ for each rule.
This is a calculation of the maximum (for the OR operator) and/or minimum (for the AND operator) performed on alpha values according to the logical connectives of Fuzzy Rules.
Several conditions may be linked together by linguistic connectives AND/OR, NOT operators and brackets.
The truth value $\omega$ and the related output singleton are used by the Defuzzyfication phase, in order to complete the inference calculation.

Figure 7.1 Fuzzy Inference


Figure 7.3 Fuzzyfication


IF INPUT 1 IS X1 AND INPUT 2 IS X2 THEN .......


### 7.4 Defuzzyfication

In this phase the output crisp values are determined by implementing the consequent part of the rules.
Each consequent Singleton $X_{i}$ is multiplied by its weight values $\omega_{\mathrm{i}}$, calculated by the Decision processor, in order to compute the upper part of the Defuzzyfication formula.
Each output value is obtained from the consequent crisp values $\left(\mathrm{X}_{\mathrm{i}}\right)$ by carrying out the following Defuzzyfication formula:

$$
Y_{i}=\frac{\sum_{j}^{N} X_{i j} \omega_{i j}}{\sum_{j}^{N} \omega_{i j}}
$$

where:
$\mathrm{i}=$ identifies the current output variable
$\mathrm{N}=$ number of the active rules on the current output
$\omega_{\mathrm{ij}}=$ weight of the j -th singleton
$X_{i j}=$ abscissa of the $j$-th singleton
The Decision Processor outputs are stored in the RAM location i-th specified in the assembler instruction OUT i.

### 7.5 Input Membership Function

The Decision Processor allows the management of triangular Mbfs. In order to define an Mbf, three different parameters must be stored on the Program/Data Memory (see Figure 7.4):

- the vertex of the Mbf: V;
- the length of the left semi-base: LVD;
- the length of the right semi-base: RVD;

In order to reduce the size of the memory area and the computational effort the vertical range of the vertex is fixed between 0 and 15 (4 bits)
By using the previous memorization method different kinds of triangular Membership Functions may be stored. Figure 7.5 shows some examples of valid Mbfs that can be defined in ST52T430/ E430.
Each Mbf is then defined storing 3 bytes in the first Kbyte of the Program/Data Memory.
The Mbf is stored by using the following instruction:
MBF n_mbf Ivd v rvd
where:
$n \_m b f$ is a tag number that identifies the Mbf
Ivd, $v$, and $r v d$ are the parameters that describe the Mbf's shape as described above.

Figure 7.4 Mbfs Parameters


Figure 7.5 Example of valid Mbfs


### 7.6 Output Singleton

The Decision Processor uses a particular kind of membership function called Singleton for its output variables. A Singleton doesn't have a shape, like a traditional Mbf, and is characterized by a single point identified by the couple ( $\mathrm{X}, \mathrm{w}$ ), where w is calculated by the Inference Unit as described earlier. Often, a Singleton is simply identified with its Crisp Value X.

Figure 7.6 Output Membership Functions


### 7.7 Fuzzy Rules

Rules can have the following structures:
if $A$ op $B$ op C...........then $Z$
if (A op B) op (C op D op E...) ...........then Z
where op is one of the possible linguistic operators (AND/OR)
In the first case the rule operators are managed sequentially; in the second one, the priority of the operator is fixed by the brackets.
Each rule is codified by using an instruction set, the inference time for a rule with 4 antecedents and 1 consequent is about 3 microseconds at 20 MHz .
The Assembler Instruction Set used to manage the Fuzzy operations is reported in the table below.

Table 7.1 Fuzzy Instructions Set

| Instruction | Description |
| :--- | :--- |
| MBF $n \_m b f / v d v$ rvd | Stores the Mbf $n \_m b f$ with the shape identified by the parameters $/ v d, v$ and $r v d$ |
| LDP $n m$ | Fixes the alpha value of the input $n$ with the Mbf $m$ and stores it in internal registers |
| LDN $n m$ | Calculates the complementary alpha value of the input $n$ with the Mbf $m$. and stores the result <br> in internal registers |
| FZAND | Implements the Fuzzy operation AND between the last two values stored in internal registers |
| FZOR | Implements the Fuzzy operation OR between the last two values stored in internal registers |
| LDK | Stores the result of the last Fuzzy operation executed in internal registers |
| SKM | Loads the result of the last performed Fuzzy operation (stored in the temporary register K ) in <br> the temporary buffer M. |
| LDM | Copies the value of register M in the data stack |
| CON crisp | Multiplies the crisp value with the last $\omega$ weight |
| OUT $n \_o u t$ | Performs Defuzzyfication and stores the currently Fuzzy output in the RAM $n \_o u t$ location |
| FUZZY | Starts the Fuzzy algorithm |

## Example 1:

IF Input ${ }_{1}$ IS NOT Mbf $_{1}$ AND Input ${ }_{4}$ is $\mathrm{Mbf}_{12} \mathrm{OR} \mathrm{Input}_{3}$ IS Mbf $_{8}$ THEN Crisp $_{1}$
is codified by the following instructions:
LDN 11 calculates the NOT $\alpha$ value of Input ${ }_{1}$ with $\mathrm{Mbf}_{1}$ and stores the result in internal registers
LDP 412 fixes the $\alpha$ value of $\operatorname{Input}_{4}$ with $\mathrm{Mbf}_{12}$ and stores the result in internal registers
FZAND implements the operation AND between the results obtained with the previous instructions
LDK stores the result of the previous operation in internal DPU registers
LDP 38 fixes the $\alpha$ value of Input $_{3}$ with $\mathrm{Mbf}_{8}$ and stores the result in internal registers
FZOR implements the operation OR between the results obtained with the previous instructions
$\operatorname{CON}$ crisp $_{1}$ multiplies the result of the last $\Omega$ operation with the crisp value crisp $_{1}$

Example 2, the priority of the operator is fixed by the brackets:
IF (Input ${ }_{3}$ IS Mbf MND $_{1}$ Input $_{4}$ IS NOT Mbf $_{15}$ ) OR ( Input $_{1}$ IS Mbf $_{6}$ OR Input $_{6}$ IS NOT Mbf $_{14}$ ) THEN Crisp ${ }_{2}$

LDP 31 fixes the $\alpha$ value of Input $_{3}$ with $\mathrm{Mbf}_{1}$ and stores the result in internal registers
LDN 415 calculates the NOT $\alpha$ value of $\operatorname{Input}_{4}$ with $\mathrm{Mbf}_{15}$ and stores the result in internal registers FZAND implements the operation AND between the results obtained with the previous instructions SKM stores the result of the previous operation in register M

LDP 16 fixes the $\alpha$ value of $\operatorname{Input}_{1}$ with $\mathrm{Mbf}_{6}$ and stores the result in internal registers
LDN 214 calculates the NOT $\alpha$ value of $\operatorname{Input}_{6}$ with $\mathrm{Mbf}_{14}$ and stores the result in internal registers FZOR implements the operation OR between the results obtained with the previous instructions LDK stores the result of the previous operation in internal DPU registers

LDM copies the value of the register M in internal DPU registers
FZOR implements the operation OR between the last two values stored in DPU registers
$\operatorname{CON}$ crisp $_{2}$ multiplies the result of the last $\Omega$ operation with the crisp value crisp $_{2}$

At the end of the fuzzy rule, by using the instruction OUT RAM_reg, a byte is written. Afterwards, the control of the algorithm returns to the CU .

## 8 A/D CONVERTER

### 8.1 Introduction

The A/D Converter of ST52×430 is an 8-bit analog to digital converter with up to 8 analog inputs offering 8 bit resolution with a total accuracy of 1 LSB and a typical conversion time of $8.2 \mu \mathrm{~s}$ with a 20 MHz clock. This period also includes the $5.1 \mu \mathrm{~s}$ of the integral Sample and Hold circuitry, which minimizes the need for external components and allows quick sampling of the signal for a minimum warping effect and Integral conversion error.
Conversion is performed in 82 A/D clock pulses.
The A/D clock is derived from the clock master. The maximum A/D clock frequency has to be 10 MHz . When the master clock is higher than 10 MHz it has to be divided by 2 using the SCK bit of the A/D configuration register REG_CONF 3 (See Table 8.1).
The A/D peripheral converts the input voltage with a process of successive approximations using a fixed clock frequency derived from the oscillator.
The conversion range is between the analog $\mathrm{V}_{\mathrm{SS}}$ and $\mathrm{V}_{\mathrm{DD}}$ references.
The converter uses a fully differential analog input configuration for the best noise immunity and

Figure 8.1 A/D Converter Structure
precision performance, along with one separate supply ( $\mathrm{V}_{\mathrm{DDA}}$ ), allowing the best supply noise rejection.
Up to 8 multiplexed Analog Inputs are available. A group of signals can be converted sequentially by simply programming the starting address of the last analog channel to be converted.
Single or continuous conversion mode are available.
The result of the conversion is stored in an 8-bit Input Register (from IR 1 to IR 8).
The A/D converter is controlled via the Configuration Register REG_CONF 3.
A Power-Down programmable bit allows the A/D converter to be set to a minimum consumption idle status.
The ST52x430 Interrupt Unit provides one maskable channel for the End of Conversion (EOC).

### 8.2 Operational Description

The conversion is monotonic, meaning that the result never decreases if the analog input doesn't and never increases if the analog input doesn't.
If input voltage is greater than or equal to $\mathrm{V}_{\text {dda }}$ (Voltage Reference high) then the result is equal to FFh (full scale) without an overflow indication.


If input voltage is less than $\mathrm{V}_{\text {SS }}$ (voltage reference low) then the result is equal to 00 h .
The A/D converter is linear and the digital result of the conversion is provided by the following formula:

$$
\text { Digitalresult }=\frac{255 \text { inputVoltage }}{\text { referenceVoltage }}
$$

Where Reference Voltage is $\mathrm{V}_{\mathrm{dda}}-\mathrm{V}_{\mathrm{ss}}$.
The accuracy of the conversion is described in the Electrical Characteristics Section.
The A/D converter is not affected by the WAIT mode.
When the MCU enters HALT mode with A/D converter enabled, the converter is disabled until HALT mode is terminated and the start-up delay has elapsed. A stabilization period is also required before accurate conversions can be performed.

### 8.2.1 Operating Modes.

Four main operating modes can be selected by setting the values of the LP and SEQ bit in the A/D configuration Register.

## One Channel Single Mode

In this mode (SEQ = ' $\mathbf{0}$ ', LP = ' 0 ') the $A / D$ provides an EOC signal after the end of channel i-th conversion; then the A/D waits for a new start event. Channel i-th is identified by the bit CHO, $\mathrm{CH} 1, \mathrm{CH} 2$.
i.e $\mathrm{CH}(2: 0)=$ '011' means conversion of channel 3 then stop.

## Multiple Channels Single Mode

In this mode (SEQ = ' 1 ', LP = ' 0 ') the $A / D$ provides an EOC signal after the end of the channels sequence conversion identified by the bit CHO, $\mathrm{CH} 1, \mathrm{CH}$; then the A/D waits for a new start event. i.e. $\mathrm{CH}(2: 0)=$ '011' means conversion of channels $0,1,2$ and 3 then stop.

Figure 8.2 Conf. Register (REG_CONF 3)

## REG_CONF 3



## One Channel Continuous Mode

In this mode (SEQ = ' 0 ', LP = ' 1 ') a continuous conversion flow is entered by a starting event on the channel selected by the $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2$ bits For example: $\mathrm{CH}(2: 0)=$ '011' means continuous conversion of channel 3. At the end of each conversion the relative IR is updated with the last conversion result, while the former value is lost.
To stop the conversion STR has to be set to ' 0 '.

## Multiple Channels Continuous Mode

In this mode (SEQ = '1', LP = '1') a continuous conversion flow is entered by a starting event on the channels selected by the $\mathrm{CH} 0, \mathrm{CH} 1, \mathrm{CH} 2$ bits. i.e $\mathrm{CH}(2: 0)=$ '011' means continuous conversion of channel $0,1,2$ and 3 .
At the end of each conversion the relative IRs are updated with the last conversion results, while the former values are lost.
To stop the conversion STR has to be set to ' 0 '.

### 8.2.2 Power Down Mode.

Before enabling any A/D operation mode, set the POW bit of the A/D configuration register to ' 1 ' at least $60 \mu$ s before the first conversion starts to enable the biasing circuit inside the analog section of the converter. Clearing the POW bit (POW = ' 0 ') is useful when the A/D is not used, reducing the total chip power consumption. This state is also the reset configuration and it is forced by hardware when the core is in HALT state (after a HALT instruction execution).

### 8.3 A/D Registers Description

The result of the conversions of the 8 available channels are loaded in the 8 Input Register from decimal address 1 to decimal address 8. (IR (1:8) see Table 2.2)). Every $\operatorname{IR}(1: 8)$ is reloaded with a new value at the end of the conversion of the correspondent analog input.
By using the assembler instruction:
LDRI RAM_Reg. IR_i
the value stored in the $i$-th IR is transferred on the RAM location RAM_Reg.
The A/D configuration register is the REG_CONF 3. Figure 6.2 illustrates the structure of this register, which manages the $A / D$ logic operation. The A/D configuration register (REG_CONF 3) is programmable as following:
b7-b5 = CH2, CH1, CHO: Last Conversion Address. These 3 bits define the last analog input. The first analog input is converted, then the address is incremented for the successive conversion until the channel identified by CHOCH 2 is converted. The $(\mathrm{CH} 2, \mathrm{CH} 1, \mathrm{CH} 0)$ bits define the group of channels to be scanned. When
setting $\mathrm{CH} 2=0 \mathrm{CH} 1=0 \mathrm{CH} 0=0$ only channel 0 is converted.
b4 = SCK: Master clock divider. ST52x430 can work with a clock frequency up to 20 MHz . The SCK must be set to ' 1 ' when the ST5 $2 \times 430$ clock is higher then 10 MHz . It is useful to set $\mathrm{SCK}=$ ' 1 ' even when the clock master is lower than 10 MHz and a high accuracy is required.
b3 = SEQ: Multiple/Single channel. When SEQ is set to ' 0 ' the channel identified by $\mathrm{CH}(2: 0)$ is converted. If SEQ is set to ' 1 ' the group of channels identified by $\mathrm{CH}(2: 0)$ are converted.
b2= POW: Power Up/ Power Down. A logical '1' enables the A/D logic and analog circuitry.
Logical level ' 0 ' disables all power consuming logic, allowing a low power idle status.
b1 = LP: Continuous/Single. When this bit is set to ' 1 ' (continuous mode), the first conversion sequences are started by the STR bit then a continuous conversion flow is processed.
When LP='0' (single mode) only one sequence of conversions is started when STR is set.
b0 $=$ STR: Start/Stop. A logical level ' 1 ' enables starting a conversion sequence; a logical level ' 0 ' stops the conversion. When the $A / D$ is running in the Single Modes ( $\mathrm{LP}==^{\prime} 0^{\prime}$ ), this bit is hardware reset at the end of a conversion sequence.

Table 8.1 A/D Conf. Register (Reg_Conf 3)

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | STR | 0 | Stop Conversion |
|  |  | 1 | Start Conversion |
| 1 | LP | 0 | Single Conversion |
|  |  | 1 | Continuous |
| 2 | POW | 0 | A/D OFF |
|  |  | 1 | A/D ON |
| 3 | SEQ | 0 | Single Channel Conv. |
|  |  | 1 | Multiple Channels Conv |
| 4 | SCK | 0 | Clock not Divided |
|  |  | 1 | Clock Divided |
| 5 | $\mathrm{CH}(2: 0)$ | 000 | Channel 0 |
|  |  | 001 | Channel 1 |
|  |  | 010 | Channel 2 |
| 6 |  | 011 | Channel 3 |
|  |  | 100 | Channel 4 |
| 7 |  | 101 | Channel 5 |
|  |  | 110 | Channel 6 |
|  |  | 111 | Channel 7 |

## 9 WATCHDOG TIMER

### 9.1 Operational Description

The Watchdog Timer (WDT) is used to detect the occurrence of a software fault, usually generated by external interference or by unforeseen logical conditions, which cause the application program to abandon its normal sequence. The WDT circuit generates an MCU reset on expiry of a programmed time period, unless the program refreshes the WDT before the end of the programmed time delay.
16 different delays can be selected by using the WDT configuration register.
After the end of the delay programmed by the configuration register if the WDT is activated (by using the assembler instruction WDTSFR), it starts a reset cycle pulling the reset pin low.
Once the WDT has been activated the application program has to refresh this peripheral (by the WDTSFR instruction) at regular intervals during normal operation in order to prevent an MCU reset.
In order to stop the WDT during user program execution the instruction WDTSLP has to be used.

The working frequency of the WDT (PRES CLK in the Figure 9.1) is equal to the clock master. The clock master is divided by 500 , obtaining the WDT CLK signal, which is used to fix the timeout of the WDT.

Table 9.1 Watchdog Timing range (CLK=5 MHz)

|  | WDT timeout period (ms) |
| :---: | :---: |
| $\min$ | 0.1 |
| $\max$ | 937.5 |

According to the WDT configuration register values, a WDT delay may be defined between 0.1 ms and 937.5 mS when the clock master is 5 MHz . By changing the clock master frequency the timeout delay can be calculated according to the configuration register values REG_CONF 2, as described in the following section.
Warning: changing the REG_CONF2 value when the WDT is active, a WDT reset is generated and the CPU is restarted. To avoid this side effect, use the WDTSLP instruction before changing the REG_CONF2.

Figure 9.1 Watchdog Block Diagram


### 9.2 Register Description

The WDT timeout is defined by setting the value of the REG_CONF 2. The first 4 bits of this register are used, obtaining 16 different delays as illustrated in Table 9.2. In Table 9.2 timeout is expressed by using the number of WDT CLK. The WDT CLK is derived from the clock master by a division factor of 500 . Timeout is obtained by multiplying the WDT CLK pulse length for the number of pulses defined by the configuration register REG_CONF 2. Table 9.4 illustrates the pulse lengths for typical values of the clock master. Table 9.3 illustrates the timeout WDT values when the Master Clock is 5 MHz .

Table 9.2 WDT REG_CONF 2

| Bit | Name | Value | Timeout Values (WDT |
| :---: | :---: | :---: | :---: |
| 0 | $D(3: 0)$ | 0000 | 1 |
|  |  | 0001 | 625 |
|  |  | 0010 | 1250 |
|  |  | 0011 | 1875 |
| 1 |  | 0100 | 2500 |
|  |  | 0101 | 3125 |
|  |  | 0110 | 3750 |
|  |  | 0111 | 4375 |
| 2 |  | 1000 | 5000 |
|  |  | 1001 | 5625 |
|  |  | 1010 | 6250 |
|  |  | 1011 | 6875 |
| 3 |  | 1100 | 7500 |
|  |  | 1101 | 8125 |
|  |  | 1110 | 8750 |
|  |  | 1111 | 9375 |
| 4-7 | NC | x | Not Used |
| Reset Configuration '0000' |  |  |  |

Table 9.3 Timeout Values with CLK = $\mathbf{5} \mathbf{~ M H z}$

| Bit | Name | Value | Timeout Values (ms) |
| :---: | :---: | :---: | :---: |
| 0 | D (3:0) | 0000 | 0.1 |
|  |  | 0001 | 62.5 |
|  |  | 0010 | 125 |
|  |  | 0011 | 187.5 |
| 1 |  | 0100 | 250 |
|  |  | 0101 | 312.5 |
|  |  | 0110 | 375 |
|  |  | 0111 | 437.5 |
| 2 |  | 1000 | 500 |
|  |  | 1001 | 562.5 |
|  |  | 1010 | 625 |
|  |  | 1011 | 687.5 |
| 3 |  | 1100 | 750 |
|  |  | 1101 | 812.5 |
|  |  | 1110 | 875 |
|  |  | 1111 | 937.5 |
| 4-7 | NC | x | Not Used |
| Reset Configuration '0000' |  |  |  |

Table 9.4 Typical WDT CLK Pulse Length

| MASTER CLK <br> $(\mathrm{MHz})$ | WDT CLK <br> $(\mathrm{KHz})$ | WDT CLK <br> PULSE <br> LENGTH (ms) |
| :---: | :---: | :---: |
| 4 | 8 | 0.125 |
| 5 | 10 | 0.1 |
| 8 | 16 | 0.0625 |
| 10 | 20 | 0.05 |
| 20 | 40 | 0.025 |

## 10 PWM/TIMER

ST52×430 offers three on-chip PWM/Timer peripherals:TIMERO, TIMER1 and TIMER2.
The ST52x430 timers have the same internal structure. The timer consists of an 8 -bit counter with a 16-bit programmable prescaler, giving a maximum count of $2^{24}$ (see Figure 10.1).

Note: In order to use TORST, TOSTR, TOCLK external signals the related pins must be configured in Input Mode by setting REG_CONF4 and REG_CONF7 registers (see Table 6.4 and Table 10.3)
For each timer, the content of the 8 -bit counter is incremented on the Rising Edge of the 16-bit prescaler output (PRESCOUT) and it can be read at any instant of the counting phase, saved in a location of RAM memory. The PWM/Timer $x$ Counter value can be read from the Input Register

Figure 10.1 Timer Peripheral Block Diagram


Next, the generic timer is called Timer x , where x can be 0,1 or 2 .
Each timer has two different working modes, which can be selected by setting the correspondent TxMODE bits of REG_CONF5, REG_CONF8 and REG_CONF10 registers: Timer Mode and PWM (Pulse Width Modulation) Mode.
All Timers have Autoreload Functions in PWM Mode.
Each timer output is available, with its complementary signal on external pins by setting PAx and PCx bits of REG_CONF12 and REG_CONF16 (see Table 10.8 and Table 10.9).
Note: In order to enable timer output (TxOUT or TxOUT) the related pin must be configured in Output Mode by setting REG_CONF4 and REG_CONF15 registers (see Table 6.4 and Table 6.6)
In particular, TIMERO can also use external START/STOP signals (Input capture and Output compare), external RESET signal and external CLOCK: PA4/TOSTRT, PAO/TORES and PA5/ TOCLK pins.

PWM_x_COUNT (Input Registers 12, 14 or 16. See Table 2.2).
The PWM/Timer x Status can be read from the Input Register PWM_x_STATUS (Input Registers 13, 15 or 17. See Table 2.2 and Table 10.10).

### 10.1 Timer Mode

Timer Mode is selected by fixing the TxMODE bit of REG_CONF5, REG_CONF8 and REG_CONF10 equal to 0 (see Table 10.1, Table 10.4 and Table 10.6).

Each TIMERx requires three signals: Timer Clock (TMRCLKx), Timer Reset (TxRES) and Timer Start (TxSTRT) (see Figure 10.1). Each of these signals can be generated internally, or, only for Timer 0 , externally by setting TORST, TOSTR, TOCLK bits of REG_CONF7 register.
TMRCLKx is the Prescaler $x$ output, which increments the Counter $x$ value on the rising edge. TMRCLKx is obtained from the internal clock signal (CLKM) or, only for TIMERO, from the external signal provided on the PA5/T0CLK pin.

Figure 10.2 Timer 0 External START/STOP Mode


When TxMSK is 1 the TIMER $x$ is
reset.
Figure 10.3 TIMEROUT Signal Type
reset.
Figure 10.3 TIMEROUT Signal Type

TIMER 0 START/STOP can be provided externally on the TOSTRT pin. In this case, the TOSTRT signal allows the user to work in two different modes by setting the TESTR configuration bit of REG_CONF5 register (see Figure 10.2) (Input capture):
LEVEL (Time Counter): If the TOSTRT signal is high the Timer starts counting. When TOSTRT is low the counting ceases and the current value is stored in the PWM_0_COUNT Input Register.

(
3) $\mathrm{TOMSK}=\mathrm{T} 1 \mathrm{MSK}=\mathrm{T} 2 \mathrm{MSK}=1$,
4) $\operatorname{TIRST} 0=$ TIRST1 $=$ TIRST2 $=1$,
5) TISTR $0=$ TISTR1 $=$ TISTR2 $=1$,
6) $\mathrm{TOMSK}=\mathrm{T} 1 \mathrm{MSK}=\mathrm{T} 2 \mathrm{MSK}=0$,
3) $\mathrm{TOMSK}=\mathrm{T} 1 \mathrm{MSK}=\mathrm{T} 2 \mathrm{MSK}=1$,

NOTE: The external clock signal applied on the TOCLK pin must have a frequency at least two times smaller than the internal master clock.
The prescaler output can be selected by setting the PRESCx bit of REG_CONF6, REG_CONF9 and REG_CONF11 registers (see Table 10.2, Table 10.5 and Table 10.7).

TxRES resets the content of the 8-bit counter x to zero. It is generated by the TIRSTx and TxMSK bits of REG_CONF5, REG_CONF7, REG_CONF8 and REG_CONF10 registers (see Table 10.1, Table 10.3, Table 10.4 and Table 10.6).
TxSTRT signal starts/stops Timer x counting only if the peripherals are configured in Timer mode. This signal is forced by setting the correspondent TISTRx bit of REG_CONF5, REG_CONF8 and REG_CONF10 registers (see Table 10.1, Table 10.4 and Table 10.6).

TxMSK bits mask the reset of each timer and can be utilized to synchronize a simultaneous start of the timers by means (for example), of the following procedure, which starts three timers:

1) TIRST0 $=$ TIRST1 $=$ TIRST2 $=0$,
2) TISTR $0=$ TISTR1 $=$ TISTR2 $=0$,
,

Figure 10.4 PWM Mode with Auto Reload


EDGE(Period Counter): After reset, on the first TOSTRT rising edge, TIMER 0 starts counting and at the next rising edge it stops. In this manner, the period of an external signal may be measured.
Timer x output signal, TIMERxOUT is a signal with a frequency equal to the 16 bit-Prescaler $\times$ output signal, TMRCLKx, divided by the Output Register PWM_x_COUNT value ( 8 bit) (Output Registers 3, 5 or 7. See Table 2.4), which is the value to count.

There can be two types of TIMERxOUT waveform:
type 1: TIMERxOUT waveform equal to a square wave with a $50 \%$ duty-cycle.
type 2: TIMERxOUT waveform equal to a pulse signal with the pulse duration equal to the Prescaler x output signal.
For each Timer x , the TIMERxOUT waveform type can be selected by setting the correspondent TMRWx bit of REG_CONF6, REG_CONF9 and REG_CONF11 registers (see Table 10.2, Table 10.5 and Table 10.7)

### 10.2 PWM Mode

For each timer, PWM working mode is obtained by setting the correspondent TxMODE bits of REG_CONF5, REG_CONF8 and REG_CONF10 registers to 1 (see Table 10.1, Table 10.4 and Table 10.6).
TIMERxOUT, in PWM Mode consists of a signal with a fixed period, whose duty cycle can be modified by the user.
The TIMERxOUT signal can be available on the TxOUT pin and the TIMERxOUT inverted signal can be available on the TxOUT pin by setting the PxSL bits of REG_CONF12 and REG_CONF16 (see Table 10.8 and Table 10.9)
The PWM TIMERxOUT period can be determined by setting the 16 -bit prescaler $\times$ output and an initial autoreload 8 -bit counter value stored in the Output Register PWM_x_RELOAD, as illustrated in Figure 10.4.
NOTE: the Start/Stop and Set/Reset signals should be moved together in PWM mode. If the Start/Stop bit is reset during the PWM mode working, the TxOUT signal keeps its status until the next start.

The Output Register PWM_x_RELOAD value is automatically reloaded when Counter x restarts counting.
The 16 -bit Prescaler x divides the master clock, CLKM, or, only for TIMER0, the external TOCLK signal, by the 16 -bit Prescaler x .
NOTE: The external clock signal, applied on TOCLK pin must have a frequency at least two times smaller than the internal master clock.
The Prescaler x output can be selected by setting PRESCx bit of REG_CONF6, REG_CONF9 and REG_CONF11 registers (see Table 10.2, Table 10.5 and Table 10.7).

When Counter x reaches the Peripheral Register PWM_x_COUNT value (Compare Value), TIMERxOUT signal changes from high to low level, up to the next counter start.
The period of the PWM signal is obtained by using the following equation:
T = (255-PWM _x_RELOAD) x TMR CLKx
where TMRCLKx is the output of the 16-bit prescaler x .
The duty cycle of the PWM signal is controlled by the Output Register PWM_x_COUNT:

## Ton =(PWM_x_COUNT- PWM_x_RELOAD)* TMRCLKx

If the Output Register PWM_x_COUNT value is 255 the TIMERxOUT signal is always at a high level.
If the Output Register PWM_x_COUNT is 0 , or less than the PWM_x_RELOAD value, TIMERxOUT signal is always at a low level.
NOTE. If PWM_x_RELOAD value increases the duty cycle resolution decreases.
By using a 20 MHz clock master a PWM frequency in the range 1.2 Hz to 78.43 Khz can be obtained.
NOTE: loading new values of the counter in the PWM_x_COUNT register, in order to avoid side effects, the PWM/Timer counter is updated only at the end of the counting cycle.

WARNING: loading new values of the reload in the PWM_x_RELOAD registers, the PWM/Timer is immediately set on-fly. This can cause some side effects during the current counting cycle. The next cycles work normally. This occurs both in Timer and in PWM mode.
When the Timers are in Reset, or when the device is reset, TxOut pins go in threestate. If these outputs are used to drive external devices it is recommended to put a pull-up or a pull-down resistor.

### 10.3 Timer Interrupt

TIMERx can be programmed to generate an Interrupt request until the end of the count or when there is an external TSTART signal. The Timer can generate programmable Interrupts into 4 different modes:
Interrupt mode 1: Interrupt on counter Stop.
Interrupt mode 2: Interrupt on Rising Edge of TIMEROUT.
Interrupt mode 3: Interrupt on Falling Edge of TIMEROUT.
Interrupt mode 4: Interrupt on both edges of TIMEROUT.
Interrupt mode can be selected by means of INTSLx and INTEx bits of the REG_CONF5, REG_CONF8 and REG_CONF10 registers (see Table 10.1, Table 10.4 and Table 10.6).

NOTE: the interrupt on TIMEROUT rising edge is also generated after the Start.

WARNING: the first interrupt after starting PWM is not generated if the counter value is 0 , 255, or lower than the reload value. If the PWM/ Timer is configured with the Interrupt on Stop and the Start/Stop is configured as external, a low signal in the STRT pin determines a PWM/ Timer interrupt even if the peripheral is off. If the interrupt is configured on falling edge, a reset signal generates an interrupt request.

Table 10.1 Configuration Register 5 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | TIRST0 | 0 | PWM/TIMER 0 Internal RESET |
|  |  | 1 | PWM/TIMER 0 Internal SET |
| 1 | TERST | 0 | External RESET on Level |
|  |  | 1 | External RESET on Edge |
| 2 | TISTR0 | 0 | PWM/TIMER 0 Internal STOP |
|  |  | 1 | PWM/TIMER 0 Internal START |
| 3 | TESTR | 0 | External START on Level |
|  |  | 1 | External START on Edge |
| 4 | INTE0 | 00 | TIMERO Interrupt on TIMER Interrupt on TIMEROUT Falling Edge |
|  |  | 01 | TIMERO Interrupt on TIMER0OUT Rising Edge |
| 5 |  | 10 | TIMER0 Interrupt on Both Edges of TIMER0OUT |
|  |  | 11 | - not used |
| 6 | INTSL0 | 0 | TIMERO Interrupt on Counter Stop |
|  |  | 1 | TIMERO Interrupt on TIMEROOUT |
| 7 | TOMODE | 0 | TIMER MODE |
|  |  | 1 | PWM MODE |

Figure 10.5 Configuration Register 5


Table 10.2 Configuration Register 6 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | PRESC0 | 00000 | TIMER0 Clock = CLKM / 1 |
|  |  | 00001 | TIMER0 Clock = CLKM / 2 |
|  |  | 00010 | TIMER0 Clock = CLKM / 4 |
|  |  | 00011 | TIMER0 Clock = CLKM / 8 |
| 1 |  | 00100 | TIMER0 Clock = CLKM / 16 |
|  |  | 00101 | TIMER0 Clock = CLKM / 32 |
|  |  | 00110 | TIMERO Clock = CLKM / 64 |
| 2 |  | 00111 | TIMERO Clock = CLKM / 128 |
|  |  | 01000 | TIMERO Clock = CLKM / 256 |
|  |  | 01001 | TIMERO Clock = CLKM / 512 |
| 3 |  | 01010 | TIMERO Clock = CLKM/1024 |
|  |  | 01011 | TIMERO Clock = CLKM/2048 |
|  |  | 01100 | TIMERO Clock = CLKM/4096 |
| 4 |  | 01101 | TIMERO Clock = CLKM/8192 |
|  |  | 01110 | TIMERO Clock=CLKM/16384 |
|  |  | 01111 | TIMERO Clock=CLKM/32768 |
|  |  | 10000 | TIMER0 Clock=CLKM /65536 |
| 5 | TMRW0 | 0 | TIMEROOUT Waveform equal to pulse wave |
|  |  | 1 | TIMEROOUT Waveform equal to square wave |
| 6 | - | - | - not used |
| 7 | - | - | - not used |

Figure 10.6 Configuration Register 6

## REG_CONF 6 <br> TIMER 0 <br> D7 D6 D5 D4 D3 D2 D1 D0

PRESCO: Timer 0 Prescaler

TMRW0: TIMEROOUT waveform
not used

Table 10.3 Configuration Register 7 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | TORST | 00 | TIMER0 RESET Internal |
|  |  | 01 | TIMER0 RESET External |
| 1 |  | 10 | TIMER0 RESET External or Internal |
|  |  | 11 | - not used |
| 2 | TOSTR | 00 | TIMER0 START Internal |
|  |  | 01 | TIMER0 START External |
| 3 |  | 10 | TIMERO START External or Internal |
|  |  | 11 | - not used |
| 4 | TOCLK | 0 | TIMER0 Clock Internal |
|  |  | 1 | TIMER0 Clock External |
| 5 | T0MSK | 0 | TIMER 0 reset synchronization mask. |
|  |  | 1 | TIMER0 reset synchronization mask. |
| 6 | T2MSK | 0 | TIMER2 reset synchronization mask. |
|  |  | 1 | TIMER2 reset synchronization mask. |
| 7 | T1MSK | 0 | TIMER1 reset synchronization mask. |
|  |  | 1 | TIMER1 reset synchronization mask. |

Figure 10.7 Configuration Register 7

## REG_CONF 7

TIMER 0, TIMER 1, TIMER2


Table 10.4 Config. Register 8 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | TIRST1 | 0 | PWM/TIMER 1 Internal RESET |
|  |  | 1 | PWM/TIMER 1 Internal SET |
| 1 | - | - | - not used |
| 2 | TISTR1 | 0 | PWM/TIMER 1 Internal STOP |
|  |  | 1 | PWM/TIMER 1 Internal START |
| 3 | - | - | - not used |
| 4 | INTE1 | 00 | TIMER1 Interrupt on TIMER1OUT Falling Edge |
|  |  | 01 | TIMER1 Interrupt on TIMER1OUT Rising Edge |
| 5 |  | 10 | TIMER1 Interrupt on Both Edges of TIMER1OUT |
|  |  | 11 | - not used |
| 6 | INTSL1 | 0 | TIMER1 Interrupt on Counter Stop |
|  |  | 1 | TIMER1 Interrupt on TIMER1OUT |
| 7 | T1MODE | 0 | TIMER MODE |
|  |  | 1 | PWM MODE |

Figure 10.8 Configuration Register 8

## REG_CONF 8

TIMER 1
D7 D6 D5 D4 D3 D2 D1 D0
TIRST1: Timer 1 RESET

- not used

TISTR1: Timer 1 START

- not used

INTE1: Timer 1 Interrupt on TIMER1OUT Rising/Falling Edge
INTSL1: Timer 1 Interrupt Source selection T1MODE: Timer 1 working mode

Table 10.5 Config. Register 9 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | PRESC1 | 00000 | TIMER1 Clock = CLKM / 1 |
|  |  | 00001 | TIMER1 Clock $=$ CLKM $/ 2$ |
|  |  | 00010 | TIMER1 Clock = CLKM / 4 |
|  |  | 00011 | TIMER1 Clock = CLKM / 8 |
| 1 |  | 00100 | TIMER1 Clock = CLKM / 16 |
|  |  | 00101 | TIMER1 Clock = CLKM / 32 |
|  |  | 00110 | TIMER1 Clock = CLKM / 64 |
| 2 |  | 00111 | TIMER1 Clock = CLKM / 128 |
|  |  | 01000 | TIMER1 Clock = CLKM / 256 |
|  |  | 01001 | TIMER1 Clock = CLKM / 512 |
| 3 |  | 01010 | TIMER1 Clock =CLKM / 1024 |
|  |  | 01011 | TIMER1 Clock =CLKM / 2048 |
|  |  | 01100 | TIMER1 Clock =CLKM / 4096 |
| 4 |  | 01101 | TIMER1 Clock =CLKM / 8192 |
|  |  | 01110 | TIMER1 Clock =CLKM/16384 |
|  |  | 01111 | TIMER1 Clock=CLKM /32768 |
|  |  | 10000 | TIMER1 Clock=CLKM /65536 |
| 5 | TMRW1 | 0 | TIMER1OUT Waveform equal to pulse wave |
|  |  | 1 | TIMER1OUT Waveform equal to square wave |
| 6 | - | - | - not used |
| 7 | - | - | - not used |

Figure 10.9 Configuration Register 9


Table 10.6 Config. Register 10 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | TIRST2 | 0 | PWM/TIMER 2 Internal RESET |
|  |  | 1 | PWM/TIMER 2 Internal SET |
| 1 | - | - | - not used |
| 2 | TISTR2 | 0 | PWM/TIMER 2 Internal STOP |
|  |  | 1 | PWM/TIMER 2 Internal START |
| 3 | - | - | - not used |
| 4 | INTE2 | 00 | TIMER2 Interrupt on TIMER2OUT Falling Edge |
|  |  | 01 | TIMER2 Interrupt on TIMER2OUT Rising Edge |
| 5 |  | 10 | TIMER2 Interrupt on Both Edges of TIMER2OUT |
|  |  | 11 | - not used |
| 6 | INTSL2 | 0 | TIMER2 Interrupt on Counter Stop |
|  |  | 1 | TIMER2 Interrupt on TIMER2OUT |
| 7 | T2MODE | 0 | TIMER MODE |
|  |  | 1 | PWM MODE |

## REG_CONF 10

## TIMER 2

D7 D6 D5 D4 D3 D2 D1 D0
TIRST2: Timer 2 RESET

- not used
TISTR2: Timer 2 START
- not used
INTE2: Timer 2 Interrupt on TIMER2OUT Rising/Falling Edge
INTSL2: Timer 2 Interrupt Source selection
INTMODE: Timer 2 working mode

Table 10.7 Config. Register 11 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | PRESC2 | 00000 | TIMER2 Clock = CLKM / 1 |
|  |  | 00001 | TIMER2 Clock = CLKM $/ 2$ |
|  |  | 00010 | TIMER2 Clock $=$ CLKM / 4 |
| 1 |  | 00011 | TIMER2 Clock $=$ CLKM / 8 |
|  |  | 00100 | TIMER2 Clock = CLKM / 16 |
|  |  | 00101 | TIMER2 Clock = CLKM / 32 |
|  |  | 00110 | TIMER2 Clock = CLKM / 64 |
| 2 |  | 00111 | TIMER2 Clock = CLKM / 128 |
|  |  | 01000 | TIMER2 Clock = CLKM / 256 |
|  |  | 01001 | TIMER2 Clock = CLKM / 512 |
| 3 |  | 01010 | TIMER2 Clock = CLKM /1024 |
|  |  | 01011 | TIMER2 Clock = CLKM/ 2048 |
|  |  | 01100 | TIMER2 Clock $=$ CLKM/ 4096 |
| 4 |  | 01101 | TIMER2 Clock = CLKM/ 8192 |
|  |  | 01110 | TIMER2 Clock= CLKM/16384 |
|  |  | 01111 | TIMER2 Clock =CLKM/32768 |
|  |  | 10000 | TIMER2 Clock =CLKM/65536 |
| 5 | TMRW2 | 0 | TIMER2OUT Waveform equal to pulse wave |
|  |  | 1 | TIMER2OUT Waveform equal to square wave |
| 6 | - | - | - not used |
| 7 | - | - | - not used |

Figure 10.11 Configuration register 11

## REG_CONF 11

TIMER 2
D7 D6 D5 D4 D3 D2 D1 D0

> PRESC2: Timer 2 Prescaler TMRW2: TIMER2OUT waveform not used

Table 10.8 Config. Register 12 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
|  | PA1 | 0 | Pin PA1/T0OUT equal to PORT A Digital I/O |
|  |  | 1 | Pin PA1/ T0OUT equal to T0OUT |
| 1 | PA2 | 0 | Pin PA2/ T1OUT equal to PORT A Digital I/O |
|  |  | 1 | Pin PA2/ T1OUT equal to T1OUT |
| 2 | PA3 | 0 | Pin PA3/ T2OUT equal to PORT A Digital I/O |
|  |  | 1 | Pin PA3/ T2OUT equal to T2OUT |
| 3 | PASZ | 0 | PORT A bits $=7$ |
|  |  | 1 | PORT A bits $=8$ |
| 4 | - | - | - not used |
| 5 | - | - | - not used |
| 6 | - | - | - not used |
| 7 | - | - | - not used |

Figure 10.12 Configuration Register 12


Table 10.9 Config. Register 16 Description

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | PC1 | 1 | Pin T0OUT/PC1 equal to PORT C Digital I/O |
|  |  | 0 | Pin T0OUT/PC1 equal to T0OUT |
| 1 | PC2 | 1 | Pin T1OUT/PC2 equal to PORT C Digital I/O |
|  |  | 0 | Pin T1OUT/PC2 equal to T1OUT |
| 2 | PC3 | 1 | Pin T2OUT/PC3 equal to PORT C Digital I/O |
|  |  | 0 | Pin T2OUT/PC3 equal to T2OUT |
| 3 | PC4 |  | 1 |
|  |  | 0 | Pin Tx/PC4 is configured as Port C Digital I/O |
| $4-7$ | - | - | Pin Tx/PC4 is configured as SCI output Tx |

Figure 10.13 Configuration Register 16

REG_CONF 16<br>DIGITAL PORT<br>\section*{D7 D6 D5 D4 D3 D2 D1 D0}<br>PC1: Pin T0OUT/PC1setting<br>PC2: Pin T1OUT/PC2 setting<br>PC3: Pin T2OUT/PC3 setting<br>PC4: Pin Tx/PC4 setting<br>not used

Table 10.10 Input Registers 13.
PWM_0_STATUS

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | STR0 | 0 | TIMER 0 is STOP |
|  |  | 1 | TIMER 0 START |
| 1 | RST0 | 0 | TIMER 0 is RESET |
|  |  | 1 | TIMER 0 is NOT |
| 2 | - | - | - not used |
| 3 | - | - | - not used |
| 4 | - | - | - not used |
| 5 | - | - | - not used |
| 6 | - | - | - not used |
| 7 | - | - | - not used |

Table 10.12 Input Registers 17.
PWM_2_STATUS

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | STR2 | 0 | TIMER 2 is STOP |
|  |  | 1 | TIMER 2 is START |
| 1 | RST2 | 0 | TIMER 2 is RESET |
|  |  | 1 | TIMER 2 is NOT |
| 2 | - | - | - not used |
| 3 | - | - | - not used |
| 4 | - | - | - not used |
| 5 | - | - | - not used |
| 6 | - | - | - not used |
| 7 | - | - | - not used |

Table 10.11 Input Registers 15.
PWM_1_STATUS

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | STR1S | 0 | TIMER 1 is STOP |
|  |  | 1 | TIMER 1 is START |
| 1 | RST1S | 0 | TIMER 1 is RESET |
|  |  | 1 | TIMER 1 is NOT |
| 2 | - | - | - not used |
| 3 | - | - | - not used |
| 4 | - | - | - not used |
| 5 | - | - | - not used |
| 6 | - | - | - not used |
| 7 | - | - | - not used |

## 11 SERIAL COMMUNICATION INTERFACE

The Serial Communication Interface (SCI) integrated into the ST52x430 fuzzy processor provides a general purpose shift register peripheral, which links several widely distributed MCU's through their SCI subsystem. SCI offers a serial interface providing communication with common baud rates up to 38,400 and flexible character format.
SCI is a full-duplex UART-type asynchronous system with standard Non Return to Zero (NRZ) format for the transmitted/received bit. The length of the transmitted word is 10/11 bits (1 start bit, 8/ 9 data bits, 1 stop bit).
SCI is composed of three modules: Receiver, Transmitter and Baud-Rate Generator. It is configured by means of Configuration Registers 19 and 20.
WARNING: IN ORDER TO WORK PROPERLY WITH SCI PERIPHERALS MAINTAINING THE DESIRED BAUD RATE A SYSTEM CLOCK OF ONLY 5, 10 OR 20 MHz MUST BE USED.

### 11.1 SCI Receiver block

The SCI Receiver block manages the synchronization of the serial data stream and stores data characters. The SCI Receiver is mainly formed by two sub-systems: Recovery Buffer Block and SCDR_RX Block.

Figure 11.1 SCI transmitted word structures


The RE configuration bit (bit 1 of the Configuration Register 20) enables the SCI Receiver when it is set to "1".
SCI receives data deriving from the RX/PC5 pin and drives the Recovery Buffer Block, which is a high-speed shift register operating at a clock frequency (CLOCK_RX) that is 16 times higher than the fixed baud rate (CLOCK_TX). This sampling rate, higher than the Baud Rate clock allows the detection of the START condition, Noise error and Frame error.

Figure 11.2 SCI Block Diagram


When the SCI Receiver is in IDLE status, it is waiting for the START condition, which is obtained with a logic level 0 , consecutive to a logic level 1.
This condition is detected if a logic level 0 is sampled after three logic levels 1 with the fixed sampling time.
The recognition of the START bit forces the SCI Receiver Block to enter in a data acquisition sequence. The data acquisition sequence is configured via Configuration Register 20 as follows.
The 2 bits, M , of the Configuration Register 20 allows the definition of the serial mode as illustrated in Table 11.1.
In the case that $\mathrm{M}=10, \mathrm{~B} \tau \mathrm{~T} 8$ is used to set the parity check in order to perform (as indicated in Table 11.1).
Recognition of the STOP condition allows data received from the Recovery Buffer to be transferred to the SCDR_RX buffer, adding the eventual ninth data bit, according to the meaning illustrated in previous Table 11.1. After this operation, the RXF flag of the SCI Status Input Register 19 (Figure 11.3) is set to logic level 1. The Control Unit reads data from the SCDR_RX buffer (in read-only mode) with the LDRI instruction, addressing Input Register 18, and provides a reset at logic level 0 to the RXF flag.
If data of the Recovery Buffer is ready to be transferred into the SCDR_RX buffer, but the previous one was not read by the Core yet, an OVERRUN Error takes place: the status flag OVERR indicates the error condition. In this case, the information stored in the SCDR_RX buffer is not altered, but the one that has caused the OVERRUN error can be overwritten by new data deriving from the serial data line.

## Recovery Buffer Block

This block is structured as a synchronized finite state machine on the CLOCK_RX signal.
When the Recovery Buffer Block is in IDLE state it waits for the reception of the correct 1 and 0 sequence representing START.
The recognition takes place by sampling the input RX/PC5 at CLOCK_RX frequency, which has a frequency that is 16 times higher than CLOCK_TX. While the external transmitter sends a single bit, the Recovery Buffer Block samples 16 states (from SAMPLE1 to SAMPLE16).
The analysis of the RX/PC5 input signal is carried out providing three samples for each bit received.
If these three samples are not equal, then the noise error flag, NSERR, of Input Register 19 is set to 1 and the data value received will be the one assumed by the majority of the samples.

The procedure above allows SCI not to become IDLE, because of a limited noise due to "an erroneous sampling". The transmission is recognized as correct and the noise flag is set.

Table 11.1 Configuration Register 20 Setting

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 | TE | 0 | Transmission |
|  |  | 1 | Transmission ENABLED |
| 1 | RE | 0 | Receiver DISABLED |
|  |  | 1 | Receiver ENABLED |
| 2 | M | 00 | 8, No Parity, 1 bit stop |
|  |  | 01 | 8, No Parity, 2 bit stop |
| 3 |  | 10 | 8, Parity, 1 bit stop |
|  |  | 11 | 9, No Parity, 1 bit stop |
| 4 | T8 | 0 | Parity Odd, if Parity is selected ( $M=10$ ); otherwise 9th Data bit |
|  |  | 1 | Parity Even, if Parity is selected ( $M=10$ ); otherwise 9th Data bit |
| 5 | BRSL | 000 | 600 baud |
|  |  | 001 | 1200 baud |
|  |  | 010 | 2400baud |
| 6 |  | 011 | 4800 baud |
|  |  | 100 | 9600 baud |
| 7 |  | 101 | 19200 baud |
|  |  | 110 | 38400 baud |
|  |  | 111 | Not Used |

At the end of the reception of a bit, Recovery Buffer Block will repeat the same step 9 times: one for the stop acquisition (10 times in case of 9 -bit data, double stop or parity check).
At the end of data reception the Recovery Buffer Block will supply information on eventual frame errors by setting the FRERR flag bit of Input Register 19 to 1 .

A frame error can occur if the parity check hasn't been successfully achieved or if the STOP bit hasn't been detected.
If the Recovery Buffer Block receives 10 consecutive bits at logic level 0, a break error occurs and an interrupt routine request starts.

## SCDR_RX Block

It is a finite state machine synchronized with the clock master signal, CKM.
The SCDR_RX block waits for the signal of complete reception from the Recovery Buffer, in order to load the word received. Moreover, the SCDR RX block loads the values of FRERR and NSERR flag bits (Input Register 19), and sets the RXF flag to 1 .
Data is transferred to RAM and the RXF flag is reset to 0 by using the LDRI instruction in order to indicate that the SCDR_RX block is empty.
If new data arrives before the previous one has been transferred to Register File, an overrun error occurs and OVERR flag of Input Register 19 is set to 1 .

### 11.2 SCI Transmitter Block

The SCI Transmitter Block consists of the following blocks: SCDR_TX and SHIFT REGISTER, synchronized, respectively, with the clock master signal (CKM) and the CLOCK_TX.
The whole block receives the settings for the following transmission modes (see Table 11.1) through Configuration Register 20 (M bits):
■ 8 -bit word and a single stop signal

- 8 -bit word plus a parity bit and a single stop signal
- 8-bit word plus a double stop signal
- 9-bit word

In case of 9 bit frame transmission, the most significative bit arrives through T8 of the Configuration Register 20.
Instead, in an 8-bit transmission T8 is used to configure SCl according to information contained in M (see Table 11.1). In particular, it is used to choose the polarity control (even or odds) in order to implement the parity check.
After a RESET signal RST, the SCDR_TX block is in IDLE state until it receives the enabling signal TE=1, of Configuration Register 20.
Data is loaded on the peripheral register (OR 9) by using the instruction LPPR or LDPE. If $\mathrm{TE}=1$ the data to be transmitted is transferred from DR_TX block and flag of Input Register 19. TXEM is reset to 0 in order to indicate that the SCDR_TX block is full.

Table 11.2 Configuration Register 19 Setting

| Bit | Name | Value | Description |
| :---: | :---: | :---: | :---: |
| 0 |  | - | Not used |
| 1 | ECKF | 00 | 5 MHz |
|  |  | 01 | 10 MHz |
| 2 |  | 10 | 20 MHz |
|  |  | 11 | 5 MHz |
| 3 | TXC | 0 | SCI End Transmission Interrupt Disabled |
|  |  | 1 | SCI End Transmission Interrupt Enabled |
| 4 | TDRE | 0 | SCI Transmission Data Register Empty Interrupt Disabled |
|  |  | 1 | SCI Transmission Data Register Empty Interrupt Enabled |
| 5 | BRK | 0 | SCI Break Error Interrupt Disabled |
|  |  | 1 | SCI Break Error Interrupt Enabled |
| 6 | OVR | 0 | SCI Overrun Error Interrupt Disabled |
|  |  | 1 | SCI Overrun Error Interrupt Enabled |
| 7 | RDRF | 0 | SCI Received Data Register Full Interrupt Disabled |
|  |  | 1 | SCI Received Data Register Full Interrupt Enabled |

Figure 11.3 SCI Status Input Register


If the core supplies new data it can't be loaded in the SCDR_TX block until the current data hasn't been unloaded on the Shift Register block. Therefore, data may be loaded in the SCDR_TX Block only when TXEM is 1 .
When the SHIFT REGISTER Block loads data to be transmitted on an internal buffer, TXEND is reset to 0 in order to indicate the beginning of a new transmission. At the end of transmission TXEND is set to 1 , allowing to load new data coming from SCDR_TX in the SHIFT REGISTER.
Note: TXEND $=1$ does not mean SCDR_TX is ready to receive new data. For this reason it is better to utilize the TXEM signal in order to synchronize the LDPR instruction to the SCl TRANSMITTER block
If the ST52x430 core resets TE to 0 , the transmission is interrupted, but the SCI Transmitter block completes the transmission in progress before reset.
Warning: after the stop bit in SCI transmission an idle time is present before the next start bit. This time is equal to the duration of a bit transmission.

### 11.3 Baud Rate Generator Block

The Baud Rate Generator Block performs the division of the clock master signal (CKM), in a set of synchronism frequencies for the serial bit reception/transmission on the external line.

Table 11.1 illustrates the set of frequencies selected by means of BRSL (Configuration Register 20).

Reception frequency (CLOCK_RX) is 16 times higher than transmission frequency (CLOCK_TX).
The following example illustrates a simple way to use SCl to receive and transmit data:

LDRC 1155

LDCR 201 These instructions load value 155 on the Configuration Register 20 fixing the Baud Rate=9600, 8 bit data, $\mathrm{TE}=1, \mathrm{RE}=1$; Parity; 1 stop bit.
LDRC 1252

LDCR 194 SCI Interrupts enabled, clock frequency 20 MHz

LDRC 1170

LDPR 91 Send data to transmission buffer
WAITI

LDRI 619 Save the SCI status register on the RAM

LDRI 118 Save the received data on a RAM register

## 12 ELECTRICAL CHARACTERISTICS

### 12.1 Parameter Conditions

Unless otherwise specified, all voltages are referred to $\mathrm{V}_{\text {ss }}$.

### 12.1.1 Minimum and Maximum values.

Unless otherwise specified, the minimum and maximum values are guaranteed in the worst conditions of environment temperature, supply voltage and frequencies production testing on $100 \%$ of the devices with an environmental temperature at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ and $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{A}}$ max (given by the selected temperature range).
Data is based on characterization results, design simulation and/or technology characteristics are indicated in the table footnotes and are not tested in production. The minimum and maximum values are based on characterization and refer to sample tests, representing the mean value plus or minus three times the standard deviation (mean $\pm 3 \Sigma$ ).

### 12.1.2 Typical values.

Unless otherwise specified, typical data is based on $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ (for the $4.5 \leq \mathrm{V}_{\mathrm{DD}} \leq 5.5 \mathrm{~V}$ voltage range). They are provided only as design guidelines and are not tested.

### 12.1.3 Typical curves.

Unless otherwise specified, all typical curves are provided only as design guidelines and are not tested.

Figure 12.1 Pin loading conditions

12.1.4 Loading capacitor. The loading condition used for pin parameter measurement is illustrated in Figure 12.1.

### 12.1.5 Pin input voltage.

Input voltage measurement on a pin of the device is described in Figure 12.2

Figure 12.2 Pin input Voltage


### 12.2 Absolute Maximum Ratings

Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only.

Functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 12.1 Voltage Characteristics

| Symbol | Ratings | Maximum Value | Unit |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}-\mathrm{V}_{\text {SS }}$ | Supply voltage | 6.5 | V |
| $\mathrm{V}_{\text {DDA }}-\mathrm{V}_{\text {SSA }}$ | Analog reference voltage( $\left.\mathrm{V}_{\mathrm{DD}} \geq \mathrm{V}_{\text {DDA }}\right)$ | 6.5 |  |
| $\left\|\Delta \mathrm{V}_{\text {DDA }}\right\|$ and $\left\|\Delta \mathrm{V}_{\text {SSA }}\right\|$ | Variation between different digital power pins | 50 | mV |
| $\left\|\mathrm{V}_{S S A}-\mathrm{V}_{\text {SSX }}\right\|$ | Variation between digital and analog ground pins | 50 |  |
| $\mathrm{V}_{\mathrm{IN}}$ | Input voltage on Vpp | $\mathrm{V}_{\text {SS }}-0.3$ to 13 | V |
|  | Input voltage on any other pin ${ }^{1) ~ \& ~ 2) ~}$ | $\mathrm{V}_{\mathrm{SS}^{-}} 0.3$ to $\mathrm{V}_{\mathrm{DD}^{+}} 0.3$ |  |
| $\mathrm{V}_{\text {DESD }}$ | Electro-static discharge voltage | 2000 |  |

Table 12.2 Current Characteristics

| Symbol | Ratings | Maximum Value | Unit |
| :---: | :---: | :---: | :---: |
| $I_{\text {VDD }}$ | Total current in $\mathrm{V}_{\text {DD }}$ power lines (source) ${ }^{3}$ | 100 | mA |
| $\mathrm{I}_{\text {VSS }}$ | Total current in $\mathrm{V}_{\text {SS }}$ ground lines (sink) ${ }^{3}$ | 100 |  |
| $1{ }_{10}$ | Output current sunk by any standard I/O and control pin | 25 |  |
|  | Output current source by any I/Os and control pin | -25 |  |
| $\mathrm{I}_{\mathrm{INJ}(\mathrm{PIN})}$ | Injected current on $\mathrm{V}_{\mathrm{PP}}$ pin | $\pm 5$ |  |
|  | Injected current on RESET pin | $\pm 5$ |  |
|  | Injected current on OSCin and OSCout pins | $\pm 5$ |  |
|  | Injected current on any other pin ${ }^{4}$ | $\pm 5$ |  |
| ${ }^{\Sigma} \underline{I N J}(\mathrm{PIN})$ | Total Injected current (sum of all I/O and control pins) ${ }^{\text {) }}$ | $\pm 20$ |  |

Table 12.3 Thermal Characteristics

| Symbol | Ratings | Maximum Value | Unit |
| :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {STG }}$ | Storage temperature range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{J}}$ | Maximum junction temperature | 150 | ${ }^{\circ} \mathrm{C}$ |

## Notes:

1. Connecting RESET and I/O Pins directly to VDD or Vss could damage the device if the unintentional internal reset is generated or an unexpected change of I/O configuration occurs (for example, due to the corrupted program counter). In order to guarantee safe operation, this connection has to be performed via a pull-up or pull-down resistor (typical: 4.7k $\Omega$ for RESET, 10K $\Omega$ for I/Os). Unused I/O pins must be tied in the same manner to VDD or VSS according to their reset configuration.
2. When the current limitation is not possible, the VIN absolute maximum rating must be respected, otherwise refer to I INJ(PIN) specification. A positive injection is induced by VIN>VDD while a negative injection is induced by VIN<Vssto I INJ(PIN) specification. A positive injection is VIN>VDD while a negative injection is induced by VIN<VSS.
3. All power (VDD) and ground (VSS) lines must always be connected to the external supply.
4. When several inputs are submitted to a current injection, the maximum $\Sigma l_{\operatorname{INJ}(\mathrm{PIN})}$ is the absolute sum of the positive and negative injected currents (instantaneous values).

### 12.3 Recommended Operating Condition

Operating condition: $\mathrm{VDD}=5 \mathrm{~V} \pm 10 \%$; $\mathrm{TA}=0 / 125^{\circ} \mathrm{C}$ (unless otherwise specified).
Table 12.4 Recommended Operating Conditions

| Symbol | Parameter | Test Condition | Min. | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}{ }^{2)}$ | Operating Supply | Refer to Figure 12.3 | 3.5 |  | 5.5 |  |
| $\mathrm{~V}_{\mathrm{PP}}$ | Programming Voltage |  | 11.4 | 12 | 12.6 |  |
| $\mathrm{~V}_{\mathrm{O}}$ | Output Voltage |  | $\mathrm{V}_{\mathrm{SS}}$ |  | $\mathrm{V}_{\mathrm{DD}}$ | V |
| $\mathrm{V}_{\mathrm{DDA}}$ | Analog Supply Voltage |  | $\mathrm{V}_{\mathrm{DD}}-0.3$ | $\mathrm{~V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}+0.3$ |  |
| $\mathrm{~V}_{\mathrm{SSA}}$ | Analog Ground |  | $\mathrm{V}_{\mathrm{SS}}-0.3$ | $\mathrm{~V}_{\mathrm{SS}}$ | $\mathrm{V}_{\mathrm{SS}}+0.3$ |  |
| $\mathrm{f}_{\mathrm{OSC}}{ }^{1)^{2} 2}$ | Oscillator Frequency |  | 2 |  | 20 | MHz |

## Notes:

1. It is reccomendend to insert a capacitor beetwen $\mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{\mathrm{SS}}$ for improving noise rejection. Reccomended values are $10 \mu \mathrm{~F}$ (electrolytic or tantalum) and/or 100 nF (ceramic).
2. In order to use SCI correctly maintaining the programmed baud rates, fosc must be set to 5,10 or 20 Mhz.
3. A lower $\mathrm{V}_{\mathrm{DD}}$ decreasing $\mathrm{f}_{\text {osc }}$ (see Figure 12.3). Data illustrated in the figure are characterized but not tested.

Figure 12.3 fosc Maximum Operating Frequency versus VDD supply


### 12.4 Supply Current Characteristics

Supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.

The test condition in RUN mode for all the IDD measurements are:
OSCin = external square wave, from rail to rail;
OSCout = floating;
All I/O pins tristated pulled to VDD $\mathrm{TA}=90^{\circ} \mathrm{C}$

Table 12.5 Supply Current in RUN and WAIT Mode

| Symbol | Parameter | Conditions |  | Typ | Max ${ }^{3}$ ) | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| IDD | Supply current in RUN mode ${ }^{1)}$ | $\begin{gathered} \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ \mathrm{~T}_{\mathrm{A}}=90^{\circ} \mathrm{C} \end{gathered}$ | $\mathrm{f}_{\text {osc }}=2 \mathrm{Mhz}$ | 4.0 | 6.0 | mA |
|  |  |  | $\mathrm{f}_{\text {osc }}=4 \mathrm{Mhz}$ | 7.5 | 10.0 |  |
|  |  |  | $\mathrm{f}_{\text {osc }}=5 \mathrm{Mhz}$, | 9.0 | 12.0 |  |
|  |  |  | $\mathrm{f}_{\text {osc }}=10$ | 17.5 | 20.0 |  |
|  |  |  | $\mathrm{f}_{\text {osc }}=20$ | 33.5 | 37.0 |  |
|  | Supply current in WAIT mode ${ }^{2}$ |  | $\mathrm{fosc}=2 \mathrm{MHz}$ | 2.0 | 3.0 |  |
|  |  |  | $\mathrm{fosc}=4 \mathrm{MHz}$ | 4.0 | 5.0 |  |
|  |  |  | $\mathrm{f}_{\text {osc }}=5 \mathrm{MHz}$ | 5.0 | 6.0 |  |
|  |  |  | $\mathrm{f}_{\text {osc }}=10$ | 10.0 | 12.0 |  |
|  |  |  | $\mathrm{f}_{\text {osc }}=20$ | 18.5 | 22.0 |  |

## Notes:

1. CPU running with memory access, all $I / O$ pins in input mode with a static value at $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{SS}}$ (no load), all peripherals switched off; clock input (OSCin driven by external square wave).
2. CPU in WAIT mode with all I/O pins in input mode with a static value at $V_{D D}$ or $V_{S S}$ (no load), all peripherals switched off; clock input (OSCin driven by external square wave).
3. Data based on characterization results, tested in production at $V_{\text {DDmax }}$ and $f_{\text {oscmax }}$.

Figure 12.4 Typical IDD in RUN vs fosc


Figure 12.5 Typical IDD in WAIT vs fosc


Table 12.6 Supply Current in HALT Mode

| Symbol | Parameter | Conditions | Typ $^{\mathbf{1}}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{DDA}}$ | Supply current in HALT mode ${ }^{2)}$ | $3.0 \mathrm{~V} \leq \mathrm{VDD} \leq 5.5 \mathrm{~V}$ | 1 | 10 | $\mu \mathrm{~A}$ |

Notes:

1. Typical data is based on $\mathrm{TA}=25^{\circ} \mathrm{C}$
2. All I/O pins in input mode with a static value at VdD or Vss (no load)

## Table 12.7 On-Chip Peripheral

| Symbol | Parameter | Conditions | Typ $^{\mathbf{3}}$ | Max $^{\mathbf{4}}$ | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: |
| IDDA | ADC Supply current when converting | fosc $=20 \mathrm{MHz}, \mathrm{V}_{\mathrm{DDA}}=5 \pm 5 \% \mathrm{~V}$, <br> $\mathrm{VSSA}^{2}=V_{S S}$ <br> $\mathrm{~V}_{S S A}=V_{S S}$ | 1 | 2 | mA |

Notes:
3. Typical data is based on $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DDA}}=5 \mathrm{~V}$.
4. Data is based on characterization results and isn't tested in production.

### 12.5 Clock and Timing Characteristics

Operating Conditions: VDD $=5 \mathrm{~V} \pm 5 \%, \mathrm{TA}=0 / 125^{\circ} \mathrm{C}$, unless otherwise specified

Table 12.8 General Timing Parameters

| Symbol | Parameters | Test Condition | Min | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {osc }}$ | Oscillator Frequency |  | 1 |  | 20 | MH |
| $\mathrm{t}_{\mathrm{CLH}}$ | Clock High |  | 25 |  | 250 | nS |
| $\mathrm{t}_{\mathrm{CLL}}$ | Clock Low |  | 25 |  | 250 |  |
| ${ }^{\text {S SET }}$ | Setup | See Fig. 11.6 |  | 5 |  |  |
| $\mathrm{t}_{\mathrm{HLD}}$ | Hold | See Fig. 11.6 |  | 5 |  |  |
| $t_{\text {WRESET }}$ | Minimum Reset Pulse | $\mathrm{f}_{\text {osc }}=20 \mathrm{MHz}$ | 100 |  |  |  |
| $t_{\text {WINT }}$ | Minimum External | $\mathrm{f}_{\mathrm{osc}}=20 \mathrm{MHz}$ | 100 |  |  |  |
| $\mathrm{t}_{\mathrm{IR}}$ | Input Rise Time | See Fig. 11.7 |  |  | 15 |  |
| $\mathrm{t}_{\text {IF }}$ | Input Fall Time | See Fig. 11.7 |  |  | 15 |  |
| $\mathrm{t}_{\mathrm{OR}}$ | Output Rise Time | $\mathrm{C}_{\text {LOAD }}=10 \mathrm{pF}$ |  | 10 |  |  |
| $\mathrm{t}_{\mathrm{OF}}$ | Output Fall | $C_{\text {LOAD }}=10 \mathrm{pF}$ |  | 10 |  |  |

Figure 12.6 Data Input Timing

Figure 12.7 I/O Rise and Fall Timing


### 12.6 Memory Characteristics

Subject to general operating conditions for VDD, fosc and TA, unless otherwise specified.
Table 12.9 RAM and Registers

| Symbol | Parameter | Conditions | Min. | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VRM | Data retention <br> mode 1$)$ | HALT mode (or <br> RESET) | 1.6 |  |  | V |

Table 12.10 EPROM Program Memory

| Symbol | Parameter | Conditions | Min. | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Werase | UV lamp | Lamp wavelength 2537 A |  | 15 |  | Watt, $\mathrm{sec} / \mathrm{cm}^{2)}$ |
| tERASE | Erase time ${ }^{\text {2 }}$ | UV lamp is placed 1 inch from the device window without any interposed filters | 15 |  | 20 | min. |
| tret | Data Retention | TA $=+55^{\circ} \mathrm{C}$ | 20 |  |  | years |

## Notes:

1. Minimum VdD supply voltage without losing data stored into RAM (in HALT mode or under RESET) or into hardware registers (only in HALT mode). Guaranteed by construction, not tested in production.
2. Data is provided only as a guideline.

### 12.7 ESD Pin Protection Strategy

In order to protect an integrated circuit against Electro-Static Discharge the stress must be controlled to prevent degradation or destruction of the circuit elements. Stress generally affects the circuit elements, which are connected to the pads but can also affect the internal devices when the supply pads receive the stress. The elements that are to be protected must not receive excessive current, voltage, or heating within their structure.
An ESD network combines the different input and output protections. This network works by allowing safe discharge paths for the pins subject to ESD stress. Two critical ESD stress cases are
presented in Figure 12.8 and Figure 12.9 for standard pins.

### 12.7.1 Standard Pin Protection

In order to protect the output structure the following elements are added:

- $A$ diode to $\mathrm{V}_{\mathrm{DD}}$ (3a) and a diode from $\mathrm{V}_{S S}(3 \mathrm{~b})$
- A protection device between $\mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{S S}$ (4)

In order protect the input structure the following elements are added:

- A resistor in series with pad (1)
- A diode to $\mathrm{V}_{\mathrm{DD}}(2 \mathrm{a})$ and a diode from $\mathrm{V}_{\mathrm{SS}}(2 \mathrm{~b})$
- A protection device between $V_{D D}$ and $V_{S S}$ (4)

Figure 12.8 Safe discharge path subjected to ESD stress


Figure 12.9 Negative Stress on a Standard Pad vs. VDD


### 12.7.2 Multi-supply Configuration.

When several types of ground ( $\mathrm{V}_{\mathrm{SS}}, \mathrm{V}_{\mathrm{SSA}}, \ldots$ ) and power supply ( $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{DDA}}, \ldots$ ) are available for any reason (better noise immunity...), the structure
illustrated in Figure 12.10 is implemented in order to protect the device against ESD.

Figure 12.10 ESD Protection for Multisupply Configuration


### 12.8 Port Pin Characteristics

### 12.8.1 General Characteristics.

Subject to general operating condition for $\mathrm{V}_{\mathrm{DD}}, \mathrm{f}_{\text {osc }}$, and $\mathrm{T}_{\mathrm{A}}$, unless otherwise specified.

| Symbol | Parameter | Condition | Min | Typ ${ }^{1)}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IL }}$ | CMOS type low level input voltage. Port B pins. (See Fig 11.13) |  |  |  | 1.5 | V |
|  | TTL type Schmitt trigger low level input voltage. Port A and Port C pins. (See Fig. 11.12) |  |  |  | 0.8 |  |
| $\mathrm{V}_{\mathrm{IH}}$ | CMOS type high level input voltage. Port B pins. (See Fig 11.13) |  | 3.3 |  |  |  |
|  | TTL type Schmitt trigger high level input voltage. Port A and Port C pins. (See Fig. 11.12) |  | 2.2 |  |  |  |
| $\mathrm{V}_{\text {hys }}$ | Schmitt trigger voltage hysteresis ${ }^{2)}$ |  |  | 1 |  |  |
| $\mathrm{I}_{\mathrm{L}}$ | Input leakage current | $\mathrm{V}_{S S} \leq \mathrm{V}_{\text {IN }} \leq \mathrm{V}_{\mathrm{DD}}$ |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $I_{s}$ | Static current consumption ${ }^{3}$ | Floating input mode |  |  | 200 |  |

## Notes:

1. Unless otherwise specified, typical data is based on $T_{A}=25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$
2. Hysteresis voltage between Schmitt trigger switching level. Based on characterization results, not tested in production.
3. Configuration is not recommended, all unused pins must be kept at a fixed voltage: using the output mode of the I/O for example or an external pull-up or pull-down resistor (see Figure 12.11. Data based on design simulation and/or technology characteristics is not tested in production.


Subject to general operating conditions for VDD, fosc, and TA, unless otherwise specified.
Table 12.11 Output Voltage Levels

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OL}}{ }^{1)}$ | Output low level voltage for standard $\mathrm{I} / \mathrm{O}$ <br> pin when 8 pins are sunk at same time. | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{IO}}=+8 \mathrm{~mA}$ |  |  | $\mathrm{V}_{\mathrm{SS}^{+}}$ <br> 0.4 | V |
| $\mathrm{~V}_{\mathrm{OH}^{2}}{ }^{2}$ | Output high level voltage for standard $\mathrm{I} /$ <br> O pin when 8 pins are sourced at same <br> time. | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{IO}=-} 8 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{DD}}$ <br> 0.5 |  |  |  |

## Notes:

1. The $\mathrm{I}_{\mathrm{O}}$ current sunk must always respects the absolute maximum rating specified in Section 12.2 and the sum of $\mathrm{I}_{\mathrm{O}}$ (I/O ports and control pins) must not exceed Ivss
2. The $\mathrm{I}_{\mathrm{IO}}$ sourced current must always respect the absolute maximum rating specified in Section 12.2 and the sum of $\mathrm{I}_{\mathrm{O}}$ (I/O ports and control pins) must not exceed IvDD.

Figure 12.12 TTL-Level input Schmitt Trigger


Figure 12.13 Port B pins CMOS-level input

| V(V) ${ }^{\text {V }}$ |  | $\begin{aligned} & V_{D D}=5 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \\ & \text { (TYPICAL) } \end{aligned}$ |
| :---: | :---: | :---: |
|  | $\mathrm{V}_{\mathrm{i}}(\mathrm{V})$ |  |

Subject to general operating condition for VDD, fosc, and TA, unless otherwise specified.
Table 12.12 Output Driving Current

| Symbol | Parameter | Test Conditions | Min | Typ | Max |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RS | Input protection resistor | All input Pins |  | 1 |  |
| Cs | Pin Capacitance | All input Pins |  | 5 |  |

Figure 12.14 Port A and Port C pin Equivalent Circuit


Figure 12.15 Port B Pin Equivalent Circuit


### 12.9 Control Pin Characteristics

### 12.9.1 RESET pin.

Subject to general operating conditions for VDD, fosc, and TA, unless otherwise specified
Table 12.13 Reset pin

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IL }}$ | Input low level voltage ${ }^{1)}$ | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  |  | 1.8 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input high level voltage ${ }^{1)}$ | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ | 2.8 |  |  |  |
| $\mathrm{V}_{\text {hys }}$ | Schmitt trigger voltage hysteresis ${ }^{2)}$ | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |  | 0.8 |  |  |
| $\mathrm{t}_{\text {w(RSTL)out }}$ | General reset pulse duration |  |  | 30 |  | $\mu \mathrm{S}$ |
| $t_{\text {h(RSTL }}$ int | External reset pulse hold time |  | 20 |  |  |  |

### 12.9.2 $\mathrm{V}_{\mathrm{PP}}$ pin.

Subject to general operating conditions for $\mathrm{V}_{\mathrm{DD}}, \mathrm{f}_{\mathrm{osc}}$, and $\mathrm{T}_{\mathrm{A}}$, unless otherwise specified.

Table $12.14 \mathrm{~V}_{\mathrm{PP}}{ }^{4}$ pin

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IL}}$ | Input low level voltage ${ }^{3)}$ |  | $\mathrm{V}_{\mathrm{SS}}$ |  | 0.2 |  |
| $\mathrm{~V}_{\mathrm{IH}}$ | Input high level voltage ${ }^{3)}$ |  | $\mathrm{V}_{\mathrm{DD}}-0.1$ |  | 12.6 | V |

## Notes:

1. Data is based on characterization results, not tested in production.
2. Hysteresis voltage between Schmitt trigger switching level.

Based on characterization results not tested in production.
3. Data is based on design simulation and/or technology characteristics, not tested in production.
4. In working mode $\mathrm{V}_{\mathrm{PP}}$ must be tied to $\mathrm{V}_{\mathrm{SS}}$

### 12.10 8-bit A/D Characteristics

Subject to general operating conditions for VDD, fosc, and TA, unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Res | Resolution |  |  | 8 |  | bit |
| $\mathrm{A}_{\text {TOT }}$ | Total Accuracy ${ }^{1}$ ) | $1 \mathrm{MHz}<\mathrm{f}_{\text {ADC }}<20 \mathrm{MHz}$ |  | $\pm 1$ |  | LSB |
| $\mathrm{t}_{\mathrm{C}}$ | Conversion Time |  |  | $82 / f_{\text {ADC }}$ |  | $\mu \mathrm{S}$ |
| $\mathrm{V}_{\text {AN }}$ | Conversion Range |  | $\mathrm{V}_{\text {SSA }}$ |  | $\mathrm{V}_{\text {DDA }}$ | V |
| $\mathrm{V}_{\mathrm{ZI}}$ | Zero Scale Voltage | Conversion result $=$ 00 Hex |  | $\mathrm{V}_{\text {SSA }}$ |  | V |
| $\mathrm{V}_{\mathrm{FS}}$ | Full Scale Voltage | Conversion result $=$ FF Hex |  | $\mathrm{V}_{\text {DDA }}$ |  | V |
| $A D_{1}$ | Analog Input Current during Conversion | $\mathrm{f}_{\text {ADC }}=20 \mathrm{MHz}$ |  | 0.1 |  | $\mu \mathrm{A}$ |
| $\mathrm{AC}_{\text {IN }}$ | Analog Input Capacitance |  |  |  | 25 | pF |
| $\mathrm{f}_{\text {ADC }}$ | ADC Clock frequency |  | $\mathrm{f}_{\mathrm{osc}} / 2$ |  | $\mathrm{f}_{\text {osc }}$ | MHz |

Notes:

1. Noise on $\mathrm{V}_{\mathrm{DDA}}, \mathrm{V}_{\mathrm{SSA}}<40 \mathrm{mV}$

Table 12.15 SS034 PACKAGE MECHANICAL DATA

| DIM | mm |  |  |  | inch. |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | TYP. | MAX | MIN | TYP. | MAX |
| A | 2.4638 |  | 2.6416 | 0.097 |  | 0.104 |
| A1 | 0.127 |  | 0.2921 | 0.005 |  | 0.0115 |
| B | 0.3556 |  | 0.4826 | 0.014 |  | 0.019 |
| C | 0.23114 |  | 0.3175 | 0.0091 |  | 0.0125 |
| D | 17.7292 |  | 18.0594 | 0.698 |  | 0.711 |
| E | 7.4168 |  | 7.5946 | 0.292 |  | 0.299 |
| e |  |  |  |  | 0.040 |  |
| H | 10.16 |  | 10.414 | 0.400 |  | 0.410 |
| h | 0.635 |  | 0.7366 | 0.025 |  | 0.029 |
| k | $0^{\circ}$ |  | $8 \circ$ | $0^{\circ}$ |  | $8^{\circ}$ |
| I | 0.6096 |  | 1.016 | 0.024 |  | 0.040 |

## 




Table 12.16 PDIP32 Shrink PACKAGE MECHANICAL DATA

| DIM | mm |  |  | inch |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | TYP. | MAX | MIN | TYP. | MAX |
| A |  |  |  | 0.140 | 0.148 | 0.200 |
| A1 |  |  |  | 0.02 |  |  |
| A2 |  |  |  | 0.120 | 0.140 | 0.18 |
| b |  |  |  | 0.014 | 0.018 | 0.023 |
| b1 |  |  |  | 0.030 | 0.040 | 0.055 |
| C |  |  |  | 0.008 | 0.010 | 0.014 |
| D |  |  |  | 1.080 | 1.100 | 1.120 |
| E |  |  |  | 0.390 | 0.410 | 0.435 |
| E1 |  |  |  | 0.300 | 0.350 | 0.370 |
| e |  |  |  |  | 0.070 |  |
| eAI |  |  |  |  | 0.400 |  |
| eB |  |  |  |  |  | 0.500 |
| eC |  |  |  |  |  | 0.055 |
| L |  |  |  | 0.100 | 0.120 | 0.150 |



D


Table 12.17 CSDIP32W Shrink PACKAGE MECHANICAL DATA

| DIM | mm |  |  | inch. |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | TYP. | MAX | MIN | TYP. | MAX |
| A |  |  |  | 0.097 | 0.115 | 0.133 |
| A1 |  |  |  | 0.025 | 0.035 | 0.045 |
| B |  |  |  | 0.016 | 0.018 | 0.020 |
| B1 |  |  |  | 0.035 |  |  |
| C |  |  |  | 0.008 | 0.010 | 0.012 |
| D |  |  |  | 1.168 | 1.180 | 1.192 |
| D1 |  |  |  | 1.042 | 1.050 | 1.058 |
| E1 |  |  |  | 0.382 | 0.390 | 0.398 |
| e |  |  |  | 0.065 | 0.070 | 0.075 |
| G |  |  |  |  | 0.375 |  |
| G1 |  |  |  |  | 0.580 |  |
| G2 |  |  |  |  | 0.044 |  |
| L |  |  |  | 0.170 | 0.175 | 0.180 |
| Q |  |  |  |  |  | 0.290 |



Table 12.18 TQFP32 PACKAGE MECHANICAL DATA

| DIM | mm |  |  | inch. |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | TYP. | MAX | MIN | TYP. | MAX |
| A |  |  | 1.60 |  |  | 0.063 |
| A1 | 0.05 |  | 0.15 | 0.002 |  | 0.006 |
| A2 | 1.35 | 1.40 | 1.45 | 0.053 | 0.055 | 0.057 |
| B | 0.30 | 0.37 | 0.45 | 0.012 | 0.015 | 0.018 |
| C | 0.09 |  | 0.20 | 0.004 |  | 0.008 |
| D |  | 9.00 |  |  | 0.354 |  |
| D1 |  | 7.00 |  |  | 0.276 |  |
| D3 |  | 5.60 |  |  | 0.220 |  |
| e |  | 0.80 |  |  | 0.031 |  |
| E |  | 9.00 |  |  | 0.354 |  |
| E1 |  | 7.00 |  |  | 0.276 |  |
| E3 |  | 5.60 |  |  | 0.220 |  |
| L | 0.45 | 0.60 | 0.75 | 0.018 | 0.024 | 0.030 |
| L1 |  | 1.00 |  |  | 0.039 |  |
| K | $0^{\circ}$ (min. $), 7^{\circ}$ (max.) |  |  |  |  |  |



## ORDERING INFORMATION

Each device is available for production in user programmable version (OTP) as well as in factory programmed version (FASTROM). OTP devices are shipped to the customer with a default blank content FFh, while FASTROM factory programmed parts contain the code sent by the customer. There is one common EPROM version for debugging and prototyping, which features the maximum memory size and peripherals of the family. Care must be taken only to use resources available on the target device.

Figure 12.16 Device Types Selection Guide


| PART NUMBER | TEMPERATURE RANGE | PACKAGE |
| :---: | :---: | :---: |
| ST52T430K1M6 | -40 to $+85^{\circ} \mathrm{C}$ | SSO34 |
| ST52T430K2M6 | -40 to $+85^{\circ} \mathrm{C}$ | SSO34 |
| ST52T430K3M6 | -40 to $+85^{\circ} \mathrm{C}$ | SSO34 |
| ST52T430K1B6 | -40 to $+85^{\circ} \mathrm{C}$ | PSDIP32 |
| ST52T430K2B6 | -40 to $+85^{\circ} \mathrm{C}$ | PSDIP32 |
| ST52T430K3B6 | -40 to $+85^{\circ} \mathrm{C}$ | PSDIP32 |
| ST52T430K1T6 | -40 to $+85^{\circ} \mathrm{C}$ | TQFP32 |
| ST52T430K2T6 | -40 to $+85^{\circ} \mathrm{C}$ | TQFP32 |
| ST52T430K3T6 | -40 to $+85^{\circ} \mathrm{C}$ | TQFP32 |
| ST52E430K3D6 | -40 to $+85^{\circ} \mathrm{C}$ | CSDIP32W |
| ST52X430/KIT |  | DEVELOPMENT KIT |

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